1		I	FEDERAL TRA	DE COMMISSI	ON
2		I	N D E X (P	UBLIC RECOR	D )
3					
4	WITNESS	S: DIRECT	CROSS	REDIRECT	RECROSS
5	Becker	1093	1166		
6	Rhoden		1187	1291	1297/1302
7					
	EXHIBI	ſS	FOR ID	IN EVID	WITHDRAWN
	СХ				
10	Number	234		1306	
11	Number	375		1202	
12	Number	488		1290	
13	Number	2466		1140	
14	Number	2729		1291	
15					
16	RX				
17	Number	507		1086	
1	Number	742		1087	
1	Number	805		1086	
20	Number	868		1086	
21	Number	888		1087	
22	Number	904		1086	
23	Number	911		1202	
24	Number	920		1087	
25	Number	1001		1291	

1	EXHIBITS	FOR ID	IN EVID	WITHDRAWN
2	RX			
3	Number 1848		1291	
4	Number 2086		1290	
5				
6	JX			
7	Number 57		1306	

## DX

10	Number	7	1162	
11	Number	8	1163	1165
12	Number	9	1163	1165
13	Number	10	1163	
14	Number	11	1164	
15	Number	12	1178	
16				
17				
1				
1				
20				
21				
22				
23				
24				
25				

1	UNITED STATES OF AMERICA
2	FEDERAL TRADE COMMISSION
3	
4	In the Matter of: )
5	Rambus, Inc. ) Docket No. 9302
6	)
7	
	Wednesday, May 7, 2003
10	9:30 am.
11	
12	
13	TRIAL VOLUME 6
14	PART 1
15	PUBLIC RECORD
16	
17	BEFORE THE HONORABLE STEPHEN J. McGUIRE
1	Chief Administrative Law Judge
1	Federal Trade Commission
20	600 Pennsylvania Avenue, N.W.
21	Washington, D.C.
22	
23	
24	
25	Reported by: Susanne Bergling, RMR
26	

2	
3	ON BEHALF OF THE FEDERAL TRADE COMMISSION:
4	M. SEAN ROYALL, Attorney
5	GEOFFREY OLIVER, Attorney
6	JOHN C. WEBER, Attorney
7	MALCOLM CATT, Attorney
	Federal Trade Commission
	601 New Jersey Avenue, N.W.
10	Washington, D.C. 20580-0000
11	(202) 326-3663
12	
13	
14	ON BEHALF OF THE RESPONDENT:
15	GREGORY P. STONE, Attorney
16	STEVEN M. PERRY, Attorney
17	PETER A. DETRE, Attorney
1	SEAN GATES, Attorney
1	Munger, Tolles & Olson LLP
20	355 South Grand Avenue, 35th Floor
21	Los Angeles, California 90071-1560
22	(213) 683-9255
23	
24	
25	
26	

```
    APPEARANCES:
    ON BEHALF OF THE RESPONDENT:
    A. DOUGLAS MELAMED, Attorney
    Wilmer, Cutler & Pickering
    2445 M Street, N.W.
```

1 PROCEEDINGS \_ \_ \_ \_ \_ 2 3 JUDGE McGUIRE: This hearing is in order and convened at 9:30 a.m. 4 Before we start today, are there any 5 housekeeping tasks that need to come to the Court's 6 7 attention? MR. STONE: Just a couple, Your Honor. The first is we signed the stipulation yesterday, it will 10 be filed this morning, on exhibits. Hopefully that meets with Your Honor's approval. 11 12 JUDGE McGUIRE: Okay. MR. STONE: You will have it later today to 13 14 look at. I neglected to move in the exhibits I used 15 yesterday. 16 17 JUDGE McGUIRE: I was going to ask you all about that today, because I thought there were quite a 1 1 few items that were at least introduced that were not 20 admitted. So, we'll go through that at this time. MR. STONE: That's correct. The ones I would 21 22 like to move into evidence are RX-507. JUDGE McGUIRE: All right, let's take them one 23 at a time. Does complaint counsel have any objection? 24 MR. STONE: That was the members' manual. 25 26

1 MR. OLIVER: If you could just remind me what they were. 2 3 MR. STONE: That was the members' manual. 4 MR. OLIVER: No objection, Your Honor. JUDGE McGUIRE: Entered. 5 6 (RX Exhibit Number 507 was admitted into 7 evidence.) MR. STONE: RX-805 was the first of the Intel road maps I showed Mr. Calvin. 10 MR. OLIVER: No objection. JUDGE McGUIRE: Entered. 11 12 (RX Exhibit Number 805 was admitted into evidence.) 13 14 MR. STONE: RX-868 was the second road map. MR. OLIVER: No objection, Your Honor. 15 JUDGE McGUIRE: Entered. 16 (RX Exhibit Number 868 was admitted into 17 evidence.) 1 MR. STONE: RX-904 was the third. 1 20 MR. OLIVER: No objection. JUDGE McGUIRE: Entered. 21 22 (RX Exhibit Number 904 was admitted into evidence.) 23 MR. STONE: RX-888 were the minutes. 24 MR. OLIVER: No objection. 25 26

1 JUDGE McGUIRE: Entered. 2 (RX Exhibit Number 888 was admitted into 3 evidence.) 4 MR. STONE: RX-920 was the email that referenced ^ Mr. Machiato. 5 6 MR. OLIVER: No objection. JUDGE McGUIRE: Entered. 7 (RX Exhibit Number 920 was admitted into evidence.) 10 MR. STONE: And RX-742 was the document from McGhee to Townsend regarding the Dell decision. 11 12 MR. OLIVER: No objection. JUDGE McGUIRE: Entered. 13 14 (RX Exhibit Number 742 was admitted into 15 evidence.) MR. STONE: Thank you, Your Honor. 16 JUDGE McGUIRE: Anything else from the other 17 side? 1 1 MR. OLIVER: No, Your Honor. 20 JUDGE McGUIRE: Perhaps it's a good time to take up a point that we have touched upon a couple 21 22 times and decide what we want to do. As the parties know, at one point at the start of this hearing, I had 23 brought out the idea of perhaps taking every other 24 25 Friday off, every two weeks, and then this topic came

26

up in short on Monday, but yet there appears to be some 1 2 conflict between the sides. Perhaps this is a time we 3 should discuss that and sort of get an understanding as 4 to how we want to proceed. Go ahead, Mr. Oliver. 5 MR. OLIVER: Thank you, Your Honor. 6 7 I guess the best way to put it at this point is simply that we had originally put together a schedule not contemplating Fridays off, and as I think I 10 probably indicated, we did have a fairly tight schedule. In response to the suggestion that we do 11 12 take some Fridays off plus some concern from the other side that certain of our initial witnesses or the 13 14 schedule of the initial witnesses may not give them sufficient time for cross, we had expanded that. 15 The issue that we now face, having completely 16 17 re-arranged our schedule, of course, we find it difficult to bring witnesses in from around the country 1 1

1 JUDGE McGUIRE: Okay, now, you say you're 2 contemplating having off this coming Friday, was that 3 your point?

4 MR. OLIVER: Friday of this week.
5 JUDGE McGUIRE: Okay -- now, Mr. Stone -- well,
6 go ahead, Mr. Oliver.

7 MR. OLIVER: If I could simply continue, I think we have continued to have discussions with the other side, and I think we have a better understanding 10 now of both what we and what they need by the way of 11 scheduling, and I think once we get a couple of weeks 12 down the road, we and they will be much more in sync in 13 terms of the scheduling.

14 JUDGE McGUIRE: Mr. Stone, do you want to
15 comment?

MR. STONE: Your Honor, we did meet yesterday afternoon after court concluded. I think we are trying to work out a schedule that accommodates all of our concerns, and we all share the interest of moving the hearing forward as expeditiously as we can to a conclusion, but we did agree that we have this Friday off if that meets with Your Honor's approval.

JUDGE McGUIRE: Yeah, that would be fine. I know we talked early on in the proceeding about the 23 23rd, I believe is two weeks from this Friday, that's

1 the holiday weekend, and I think we had an

2 understanding at least in part that we would take off 3 the 23rd. From the Court's point of view, you know, we 4 all have other affairs we have to attend to. I have an 5 office I have to oversee in the meantime, so I try to 6 put things off. So, I need some time, and a day every 7 two weeks would certainly I think give the Court the time it needs to handle its other affairs.

I would like -- and we -- it doesn't have to be every other Friday, but at least take a day off every two weeks. I was contemplating that that might be an excellent day, because I know some counsel is from out of town, you may want to go home and see your family or whatever. You have other of your own affairs you have to tend to.

16 So, it would be the Court's desire to go ahead 17 and attempt to schedule to take off every other Friday 1 starting with this Friday, and then we'll be off on the 1 23rd, and I guess it would be June 6th and then June 20 20.

21 MR. STONE: Could I ask you about that week 22 that -- because that's the week my son graduates, as I 23 had mentioned to you.

24 JUDGE McGUIRE: Maybe we can make an 25 adjustment.

1 Fridays and to accommodate more time for respondents with certain of our early witnesses, that has extended 2 3 the length of our case, and I think it's likely that we 4 will go most of the way through June in our case. JUDGE McGUIRE: Okay, you will go through June 5 with your case. 6 7 MR. OLIVER: Yes. JUDGE McGUIRE: So, we are talking probably through the end of July almost before we are going to 10 complete this hearing, correct? MR. STONE: Yes, we're afraid that's what it 11 12 looks like. JUDGE McGUIRE: Okay, that's why we're talking 13 14 about it. All right, are there any other housekeeping 15 tasks that we need to address? 16 17 MR. STONE: Not for us, Your Honor. JUDGE McGUIRE: Okay. At this time, then, 1 1 complaint counsel may call its next witness. 20 MR. CATT: Good morning, Your Honor. I'm Malcolm Catt. I'm representing complaint counsel 21 22 today. JUDGE McGUIRE: And how is that spelled, Mr. 23 24 Catt? MR. CATT: C-A-T-T. 25 26

1 JUDGE McGUIRE: C-A-T-T, okay. 2 MR. CATT: Complaint counsel would like to call 3 to the stand Henry Becker. 4 JUDGE McGUIRE: Mr. Becker, could you please approach the Bench and you will be sworn by the court 5 6 reporter. 7 Whereupon--HENRY SCOTT BECKER a witness, called for examination, having been first 10 duly sworn, was examined and testified as follows: 11 DIRECT EXAMINATION 12 BY MR. CATT: Q. Good morning, Mr. Becker. 13 14 A. Good morning. 15 Q. Can you state your full name for the record, please? 16 17 A. Henry Scott Becker. Q. And what's your current occupation? 1 1 A. I'm vice president and managing director for 20 the Infineon Technologies Richmond factory. 21 Q. What does Infineon Technologies do? 22 A. Infineon produces and manufacturers semiconductors. 23 24 Q. Have you ever testified before, Mr. Becker? A. Yes, I have. 25 26

- 1 Q. When was that?

•	
2	A. Two years ago in a case between Infineon
3	Technologies and Rambus in Richmond District Court.
4	Q. Other than testifying, did you attend other
5	days of that trial?
6	A. I attended the entire trial, about two weeks.
7	Q. And why was that?
	A. I was the corporate representative.
	Q. Do you have any ongoing involvement in the
10	Infineon-Rambus litigation?
11	A. Personally, no. You know, I follow it through
12	the newspapers and things like that.
13	Q. Okay. I want to go back in time now. Can you
14	start by giving me your educational background?
15	A. Yeah, I graduated from Ohio State University in
16	1984 with a Bachelor of Science in electrical
17	engineering.
1	Q. And after you completed your degree, what did
1	you do then?
20	A. I went to work for Motorola, relocated to
21	Phoenix, Arizona, and worked in one of their
22	manufacturing areas.
23	Q. Can you give me a little more specifics on what
24	you did?
25	A. Yeah, I sure can. I worked in one of their
26	

1 that project?

2	A. Yeah, once again, I was an engineering manager
3	assigned to that project. This time I was one of three
4	people, so we took the factory and divided it into
5	three pieces, worked very closely with the architecture
6	and engineering firm. Again, we started with a clean
7	sheet of paper, defined the size of the factory, the
	support spaces, the adjacencies, everything that needed
	to function.
10	I worked on that for about six months. So,
11	we in that six-month time frame, we got fairly far
12	along with the design, but we hadn't started anything
13	else at that point.
14	Q. And what was that factory going to produce?
15	A. That was intended to be a microprocessor
16	factory.
17	Q. Okay. And what sort of microprocessors were
1	going to be produced?
1	A. Well, the main cut m10.9(me )10.9(Ira)10.9(s t)10.9(hd )10.9pplmaC0(

Q. So, with that project then at an end, where did
 you go then?

A. After that project, I got assigned to a joint
venture project between Motorola and Siemens
Semiconductor, and Siemens Semiconductor eventually
became Infineon Technologies, and the joint venture was
intended to manufacture DRAMs. It also was located in Richmond, Virginia.

Q. And when did you actually join that project?
10 A. Summer of 1996, in the June or July time frame.
11 Q. So, can you give me a little more specifics on
12 your duties as that project got underway?

A. Once again, I was brought on as an engineering 13 14 manager. Once again, I was responsible for a third of 15 the factory, interfaced very closely with the engineering and architectural firm. We started with a 16 17 clean sheet of paper once again to define the size of the clean room, the support -- the support spaces, the 1 adjacencies, the functionality, the things that went in 1 20 there and answered questions for them, interfaced with 21 the construction team and the project managers once 22 again to keep the project on track, answer their questions and make sure it was headed in the right 23 24 direction.

25 As engineering manager, I was in the process or 26

1 responsibility for about nine months, although we still

2 don't have the equipment up today at the factory, so

3 it's really an ongoing concern.

1 still a lot more work to be done.

2	Q. Okay. So, once you did that first run, did you
3	continue in the same duties or did they change?
4	A. After being facilities manager for about nine
5	months, in the March of I think it was March of '99,
6	I got responsibility for the whole wafer fab,
7	engineering, maintenance and manufacturing.
	Q. When you say the whole wafer fab, are you
	you've used the term "fab," and I think you said it was
10	a how did you what did you say that term means,
11	actually?
12	A. Fab is semiconductor short-term for wafer
13	

Q. Okay. So, once you became managing director,
 what were your duties then?

3	A. Well, in addition to being responsible for the
4	fab and it meeting its production commitments, we also
5	have a back-end assembly and test area where we do
6	component manufacturing. I'm responsible for that. We
7	also have a memory module assembly and test
	manufacturing area that I'm responsible for. And then
	all the support functions that go along with an overall
10	site, such as HR, finance, information technology, all
11	those kinds of things. So, I'm responsible for all
12	those aspects as well.
13	Q. Have you ever had experience actually designing
14	DRAMs?
15	A. No, I've never been a designer.
16	

1

5

little quicker, huh?

All right, I think we have pulled up a slide 2 here. Can you tell me -- describe to me what this 3 4 slide is showing us?

A. This is intended to demonstrate what a fully integrated manufacturing site looks like, and I briefly 6 7 touched on that just a couple of minutes ago where I talked about we do front-end wafer processing, component and memory module.

10 If you look at the -- if you look at the screen, the white wafer labeled bare wafer on the far 11 left is what we start with. We purchase those from --12 from bare wafer suppliers around the world, and that's 13 14 how we start our process.

15 The second one that says processed wafer, that's to represent what a finished wafer that's been 16 17 through our front end of the manufacturing looks like, and you can see the cross-hatched pattern on there is 1 to indicate that there's a lot of individual DRAM chips 1 20 on that single wafer.

As you move to the right, you can see that the 21 22 wafer has been modified a little bit, and it's labeled individual chips. What we do next, after we finish the 23 front-end wafer fab processing, we electrically test 24 25 each chip that's on the wafer. We cut the wafer up to

release the individual chips. We then take the good
 ones and process them further.

3 Further processing, we take those individual 4 chips and we put them into a -- what's labeled a packaged chip or also known as a component. Those are 5 tested, and those good ones then are ultimately built 6 7 into a memory module, which is at the bottom labeled finished module, and that's something that you can put directly into your PC or that we would sell our 10 customers. Q. I think that while you described them there, 11 you mentioned the term "front end." Can you tell me 12 where that fits into here? 13 14 A. Yeah, on this demonstrative, bare wafer and processed wafer, those two would be part of the front 15 end of the process. The other three pieces that you 16 17 see, individual chips, packaged chips and finished module, would be part of what we term back-end 1 manufacturing. 1 20 Q. Okay, we can pull up the next slide. Can you describe to me what this is showing us? 21 22 A. Yes, this is an aerial photograph of the Infineon Richmond plant. 23

Q. Can you -- I see there's different labels on
the buildings. Can you tell me what they all mean?

1 what those are?

2	A. Yeah, all the way in the back of the site near
3	the tree line that you can see towards the back center,
4	that's the our electrical substation that's on site.
5	When we started here, there was nothing literally but
6	trees, and that's how power was brought into the site.
7	Q. I suppose you use quite a lot of power.
	A. We use a lot of power, the equivalent of about
	4500 homes.
10	Q. Before that, those white towers there, what are
11	those?
12	A. That's some of our gas infrastructure. Those
13	are part of our bulk gas back pads. The white towers
14	specifically are air separation plants. They take the
15	air and turn it into high purity nitrogen and high
16	purity oxygen to be used in the manufacturing process.
17	Q. Any other stuff back there that I've missed?
1	A. Some other buildings in the background that are
1	a little bit harder to see, behind the Fab 1 is a
20	building known as the CUB or the Central Utility
21	Building for that side of the factory. That's where we
22	make our hot water, our cold water for temperature and
23	humidity control. That's where we make our ultra clean
24	water, some emergency generation power systems back
25	there for emergency situations, and a handful of other
26	

1 facilities-related processes are in that building. 2 Next to it, beside the PATM building, is an 3 industrial building. That's where all our liquid waste 4 goes to be treated or hauled away. And then there is another building that you can't see behind the Fab 2. 5 6 That's the Central Utility Building in support of that part of the expansion. It has the same function as the 7 other CUB building. Q. And how big actually is this whole factory? 10 A. Total site under roof is about 1.35 million square feet. 11 12 Q. Okay. And then how many people are working in this building? 13 14 A. Just under 1750. Q. And how long did it take to -- from cutting 15 down the trees to actually getting this building where 16 it 2791 Tm.06c61 Tm.06Tf9.96 T1 Tf9.96 088.59 0 0 9 62.0401 01 536.9995 Tm0 17

- 1 A. Phase one --2 JUDGE McGUIRE: All right, Counsel, how is that 3 of any importance to this proceeding? 4 MR. CATT: Your Honor, the -- part of what the case I believe is about is the cost involved in 5 actually making the products and the big investments 6 7 that these companies have to put in that affects their ability to actually -- to move -- to get out of the business or to change the business. 10 JUDGE McGUIRE: Okay, go ahead. THE WITNESS: The total investment on the site 11 is about \$1.7 billion. Phase one that's currently 12 operational is a little bit over 1.5. 13 14 BY MR. CATT: Q. Okay. What actually -- what does that money 15 actually go into? Why is it so expensive? 16 17 A. Well, if you look at the \$1.5 billion on phase one that's currently operational and exclude the 1 expansion portion, about \$350 million was for the 1 20 buildings and the building infrastructure, office 21 furniture, computer systems, facilities systems, things 22 like that. The balance, about \$1.2 billion, is in the actual processing equipment that we would manufacture 23 the components and the modules with. 24 25 Q. Let's go to the next slide.
- 26

Can you tell me what this depicts? 1 2 A. Yeah, this is an architectural drawing of the clean room for the wafer fab manufacturing space that 3 4 we saw labeled Fab 1 on the previous demonstrative. The small red boxes are individual pieces of process 5 equipment. I guess the fuscia or the purple color 6 7 lines are interior walls. And then each of the functional process areas are labeled, such as films, etch, wets and so on. 10 Q. Can we go to the next slide? What's this depict? 11 A. This is that same building but now a 12 cross-section depicting the three levels within the 13 building. The -- moving from top to bottom, that would 14 15 be the interstitial, the clean room and the sub-fab. Q. What happens in the sub-fab? 16 17 A. The sub-fab is kind of like the basement in your house, you know, where you have your furnace, your 1 1 hot water heater. The sub-fab contains the support 20 equipment that allows the actual process equipment 21 that's on the clean room level to function. You might 22 have pumps down there, you might have chillers, heat exchangers, point-of-use abatement systems, those kinds 23 of things. 24 25 The other thing that the sub-fab is used for is

- 1 Q. How many times?
- 2 A. 10,000.
- 3 Q. 10,000 times cleaner than a hospital operating
- 4 room?
- 5 A. Yes.
- 6

1	center there, there's a very small yellow circle
2	labeled "DRAM Chip Killer Defect," and that's at 0.3
3	microns, and that's more than large enough to cause a
4	defect on a chip that would render it inoperable and we
5	would have to throw it away.
6	Q. Let's go to the next slide.
7	

1 can see that if the one-micron particle falls on the 2 three-micron technology, chances are pretty good it's 3 not going to cause a problem. It's not going to bridge 4 those two lines together, is not going to create a 5 problem.

When you get to a two-micron particle or 6 7 certainly a five-micron particle, that's certainly big enough to cause an issue. So, if that five-micron particle fell on those two three-micron lines prior to 10 the patterning and the creation of that image, chances are that we would have metalization underneath that 11 five-micron particle, thus shorting those two lines out 12 and creating a defect that would cause the chip to be 13 14 no longer good.

15 As you shrink the technology and we move down to the 1.5-micron technology example, we now have three 16 17 1.5 micron lines with the same one-micron, two-micron and five-micron defects laying on top. You can see 1 that the five-micron is even more than big enough, has 1 20 no chance of falling anywhere where it won't create a problem, will always be a killer defect. The 21 22 two-micron could create a -- is more than big enough to create a problem with that center metal line, and even 23 a one-micron particle may cause some problems. 24

If you go to the bottom and look at the

26

1	0.14-micron technology, which is what we manufacture in
2	Richmond, it may look like one big fat line, but in
3	reality it's a bunch of small lines. The technology is
4	now small enough where it's hard to differentiate those
5	

1

reasonably keep most of those particles in.

2 Q. So, when I'm waving my hand around here, my particles are landing on Mr. Stone over there? 3 4 Α. They are landing somewhere. Okay. 5 Q. The -- the -- to finish my answer, the third 6 Α. 7 thing we do is we move a lot of air through the clean room, and we briefly touched on that when we looked at the cross-section of the building demonstrative, and 10 the idea is there that we know that we can't prevent 11 all the particles from becoming present in the clean room, but when they do present themselves there, the 12 air is moving at about 70 feet per minute straight down 13 14 from the ceiling to the floor in a laminar flow 15 direction, and that particle immediately is washed away so it doesn't have the opportunity to land on a wafer. 16 17 Ο. So, the air carries the particles away? Carries them away immediately. 1 Α. Q. Okay, another couple of things here. 1 20 Your Honor, may I approach? 21 JUDGE McGUIRE: Yes. 22 MR. CATT: Here, Your Honor. JUDGE McGUIRE: Thank you. 23 24 MR. CATT: Your Honor, what I've just given 25 you, one of those I think Infineon would like to get in 26

1 camera treatment for it. They don't want to have the 2 courtroom cleared, but they just want to make sure if 3 we hold onto it, it gets --

JUDGE McGUIRE: You mean in camera in terms that we are not going into it here today in the public session or in camera meaning you want me to keep these in my office secure?

MR. CATT: I think that's what we mean. They -- Infineon's lawyers are here, and they could orally argue about that if --

10

JUDGE McGUIRE: As far as I'm concerned, at the end of the testimony, you know, you can have these back. I don't think, you know, I'll need to keep them 14

1 that I've just handed up?

A. Yeah, you've handed me two silicon wafers. The first one, labeled Bare Silicon Wafer, is what I referred to as what we purchase as our starting point for the manufacturing process. There's no patterning on here. It's a very shiny mirror finish, very smooth, very flat and defect-free.

Q. Okay. And the second one?

A. The other one that you handed me is a finished 10 wafer. This is what they look like fully processed at the end of the front end or the wafer manufacturing 11 process, and if you look on the -- if you look on the 12 wafer, you can see that there's a lot of patterning on 13 14 here, and there's literally hundreds of in this case 256-meg double data rate DRAM chips on the wafer. 15 Q. Okay. Now, does the manufacturing in a DRAM 16 17 fab work like a traditional assembly line? A. No, actually, that's an example I use on tours 1

to tell you what it's not like. Most people can picture an automobile factory assembly line where you start at one end with the frame and it slowly moves from one end to the other end of the factory and you add pieces to it until you get a finished car and you drive it off the end of the assembly line.

clean room, we had process areas, and for instance, the 1 2 films area, the one in the upper left-hand corner I 3 believe was labeled, is an area of light process 4 equipment performing light processes but not necessarily in any sequential order. Instead of having 5 a linear flow through our factory, we have what we call 6 7 re-entrant flow, which means that we go to one process area, then another process area, then possibly a third process area, and then we will re-enter maybe that 10 first process area, go to a fourth, re-enter that 11 second, and we do that throughout the wafer fab to the tune of about 400 steps. 12 Q. Okay, I believe we have some slides that you've 13 14 brought which should help us get through that process. What's this first slide? 15 This is the first of a series of demonstratives 16 Α. 17 that we put together to try to demonstrate how to make a simple transistor and how that would function through 1 a factory like mine. What you see here is -- in the 1 20 big white box to the left side, there's a gray wafer, and you can see it's -- in trying to depict that 21 22 there's multiple chips on that wafer. One of those chips in purple has been blown up, and then there's a 23 small gray byte or square in the upper right-hand 24 25 corner that's been shown there.

All we're trying to demonstrate with this demonstrative, and we will take that very, very small piece of that wafer of that chip and show you what might happen to that as we manufacture a single transistor, and that would represent that gray box at the bottom of the demonstrative.

7

11

Q. Okay, let's go to our next slide.

A. The second demonstrative has the same layout as probably the next seven or eight do, and what it tries
10 to show is in the upper left-hand corner is a

scaled-down version of the clean room schemati8 as

1 silicon that we started with on the previous page, and 2 then the first step we do is we go ahead and grow a 3 silicon dioxide in the diffusion area, and it's 4 represented by the orange film that is now blanketed across the wafer. 5 ο. What do you mean? How do you grow something? 6 7 A. Well, it's kind of like growing rust on metal, you know, you expose metal to air, and you get the right environmental conditions, you can assume some of 10 that metal and you create iron oxide. Silicon dioxide 11 is done just the same way but in a much more controlled 12 manner. What we do is we put the wafers in a diffusion 13 14 furnace, elevate the temperature to over a thousand 15 degrees C, we introduce some oxygen into the environment and we do a controlled growth or a 16 17 controlled chemical reaction on the surface of the wafer. 1 1 Q. Okay. So, this is -- so far we -- this slide 20 is showing that you've grown an oxide layer. Let's go to the next slide. 21

A. So, as we proceed on with the production or the

is a picture of the Richmond lithography area. It may 1 2 look like a bad picture because it has a yellow haze to 3 it, but in actuality the room is yellow, and it's 4 yellow because in the lithography area we use materials that are sensitive to light and could be negatively 5 impacted by white light. So, this light here in the 6 7 courtroom, for example, we couldn't have in there, so everything has got a yellow filter on it in that area.

As we go to the right side of the 10 demonstrative, now that oxide has had that photosensitive material, also known as photo resist, 11 applied as a blanket across the wafer. If we move to 12 the block to the right of that one at the top row, we 13 14 have introduced a mask.

15 Q. Okay, let me interrupt you now, because I think we actually have a mask, too. 16

17 MR. STONE: I feel cheated that I don't get my own set, but I guess --1

1 MR. CATT: They are so expensive, we can't 20 afford to give you one. I will give one to the Bench, we can describe it, if you can be a little careful with 21 22 this one.

JUDGE McGUIRE: I'm careful with everything. 23 BY MR. CATT: 24 25

Q. Can you describe what we've just handed up

1 there?

A. That's a mask. They are also sometimes known as a reticle. There's an image on that mask that we eventually want to transfer to the wafer, and that's one of, say, 22 masks that are required to build a DRAM, a typical process flow. The image on the mask is four times larger than what ends up on the wafer.

The mask will go into a photolithography exposure tool, and it will sit well above the wafer. 10 The wafer will sit down here, and in between there 11 there's a series of lenses, what are also known as a 12 lens column, that will reduce that image, clean it up 13 and make it very, very clean so that when it gets 14 exposed on the wafer, it's in focus and it does what it 15 needs to do.

I don't know how many chips are on there, but we don't -- when we use the mask like that, we don't expose the entire wafer, at a time we expose a portion of the wafer and do maybe three, six or eight chips at a time, and then we will step to the side of that, do that exposure process again in step until we cover the

A. At today's technology levels, an entire mask
 set costs about a million dollars.

3 Q. A million dollars. And how many masks are in a 4 set?

5 A. Anywhere from 20 to 25 to make DRAMs.

Q. Okay. So, it's important we don't drop it.
Okay, let's continue on with that slide we've got up, and -- no, going back to the last one. I think you were talking about the mask.

10 A. Yes, so we introduce the mask, and that's 11 represented by the second block to the right, and you 12 can see it's got a U-shaped pattern to it. The next 13 thing we do is we shine a light over the mask onto the 14 wafer itself, and you can see -- underneath the mask, 15 you can see the shadow of the mask is projected onto 16 the wafer and onto that photosensitive material.

17 After we do that, we go ahead and develop the wafer, and the photo resist that was exposed to light 1 is basically washed away, its chemical properties have 1 20 been changed by the light, and where the light didn't touch it, it's been left behind. So, we have 21 22 transferred the pattern from the mask onto the photo resist that's sitting on top of the orange oxide on the 23 silicon. 24

25 Q. Let's go to -- is there anything else you want 26

- 1
- to describe on that slide?

A. No, I think if we go to the next demonstrative,
we will continue on with the process.

4 Q. Okay.

A. Now we've highlighted the etch and the wets 5 area. The picture below is part of the etch area. Ιf 6 7 you look to the right, you can see we've got that same photo resist U pattern sitting on the oxide at the beginning. The next thing we do is we go to the etch 10 area, and we use that photo resist to mask the etch on the wafer. And what we do is we take that wafer, put 11 it into an etch chamber, introduce a specific gas or 12 chemical that preferentially reacts with the silicon 13 14 dioxide but at the same time does not react with the photo resist, thereby etching away any exposed oxide. 15 16 After the etch area, we go to the wets area, 17 and we clean that photo resist off, and now we have effectively transferred the pattern from the mask 1 through the sacrificial photo resist onto the silicon 1 20 wafer and form the pattern on the oxide as you can see at the bottom. 21

22 Q. The slide, that is at the etch area or the wets 23 area?

24 A. That's the etch area.

Q. Okay. I've noticed the guys in the bunny suits 26 1 there, they seem to always be wearing glasses of some 2 type. Why is that?

A. That's for safety considerations.
Q. Okay. And along the top of the room there, I
see some sort of bars going along. What's that?
A. That's actually a kind of a monorail system
that we use to automatically move the lot boxes from one part of the factory to another.

Q. So, that's how the wafers get around through 10 the process?

A. That's how we get from one processing area to another. The manufacturing associates or operators that you see there in the bunny suits actually take the boxes and carry them to the individual tools.

15 Q. Okay. Are we ready for the next slide? 16 A. Yeah, if we can go to the next demonstrative, 17 we've highlighted the films area here. Underneath there's a picture of our films area, part of our films 1 area. We start with the same patterned oxide. We now 1 in the films area deposit a couple of different blanket 20 films. The first one is a deposited oxide, as depicted 21 22 by the very light yellow blanket layer. The one after that is a type of silicon called polycrystalline 23 silicon depicted by the blue color. So, in the films 24 25 area, we have just deposited two films on top of the

1 wafer.

2	Q.	Okay.

A. If we go to the next demonstrative, we have highlighted the etch, wets and lithography area again. The picture below there is a picture of the wets area. Those are two big wet hoods on either side of the manufacturing associate. If you look over to the right, we've introduced a second mask. It has a different pattern than the first mask.

10 When you're making semiconductors, it's very 11 critical that we align one mask to the one below it and the other features very, very carefully and very, very 12 correctly, both from the X/Y direction and from a 13 14 rotation standpoint. We go ahead and expose that with 15 light again, treating the photo resist. We develop the photo resist away, leaving that green stripe in the 16 17 middle.

We then go to the etch area. We have a -- we select our chemistries such that they don't touch the photo resist, but they will etch away the blue polysilicon and the yellow -- light yellow oxide that was deposited, but also at the same time not touch the thermally grown silicon dioxide. So, the second picture is what's left after the etch.

25 Then if you go to the third picture at the
26

1

a maintenance technician.

2 Q. Okay, all right. Okay, you were explaining on 3 the right, I guess.

4 A. Okay, if we go to the right, the first picture in the upper left-hand corner is where we left off in 5 the previous demonstrative. The next one is -- it 6 7 looks like it's in the middle of a sand storm kind of a picture, and that's to illustrate that we're ion-implanting the wafer, and what we're doing there is 10 we're taking a positively or a negatively charged ion, for this case let's just assume it's positively 11 charged, and we're accelerating it, purifying it and 12 literally slamming it into the wafer. We're implanting 13 14 it into the wafer, and the oxide and the polysilicon will keep the ions from doing anything or affecting the 15 wafer at all, but where it has the gray silicon stripes 16 17 on either side of the blue stripe, that's where we want to put that dopin or those ions. 1

And you can see in the third photograph, we've now got a grainy, sandy type of color there, and that's a stripe that we've now implanted in that section, but when we implant it, we really haven't made that impact effectively until we anneal it, and we anneal it for two reasons. One, we want to make the ions electrically active, and the other reason is that when

1 Q. Sure.

2	A we've highlighted the lithography, the etch
3	and the wets area again, because we are going to repeat
4	that patterning process, another picture of the
5	lithography area, and then we take the chip that's
6	or the transistor that's covered with metalization, and
7	we would come in with a fourth mask. We would pattern
	that mask, expose it, develop it. We would etch it
	with the preferential chemistry to etch the metal but
10	not touch the dielectric, and then we would clean the
11	photo resist off, and we would be left with these three
12	metal terminals, if you will, that would now form a
13	finished transistor.
14	Q. Okay. And so is that is there more to the
15	front-end part of the process, or is that it?
16	A. This was a very simple example of making a
17	simple transistor on a very small part of that wafer,
1	but in actuality, when we make DRAMs, instead of four
1	masking layers and maybe 25 steps that we went through
20	here, we'll have 22 masking layers and about 400
21	process steps. So, it's a lot more complicated, and
22	you're making a lot more than just one transistor.
23	You're making literally hundreds of millions of them
24	per chip at the same time.
25	Q. And how long does it take to get through that

1	then on the right is a piece of a finished process
2	wafer in the upper right-hand corner. Once again,
3	after that, we would electrically test it and dice them
4	up and build into a component the good chips.
5	If you look across the bottom of the lucite, we
6	try to go into a little bit more detail on how the
7	component in the module process works. If you look at
	the bottom on the left-hand side, you will see this
	kind of a metal lattice-looking like structure.
10	There's four locations. In the first location well,
11	first of all, this metal lattice thing is we call it
12	a lead frame, and if you look on here, the first
13	location is just the lead frame by itself.
14	The second location has a chip that's been cut
15	up from the wafer and bonded to the lead frame, or what
16	we would call die-bonded. The thirTm.0663 Tc[( )10.9( )10.9( )10.9( Th

wires and the chip from damage. A couple of steps that are missing basically are tool and die type of mechanical punch operations that separate the individual chips from the lead frame and bend the leads and cut them, and you can see the thing in the middle at the bottom labeled a component is what we would have at the end of that.

Now, after we assemble them, we do a lot of testing to ensure that those components are still good 10 after that assembly process. We will do functional 11 testing, we will do what we call burn testing, which is a functional test followed by an over-stress situation. 12 We may increase the voltage that we bias the part at 13 14 and increase the temperature at which it operates. Then we will functionally test it again in after-burn 15 and try to find any early failures or what we would 16 17 call infant mortality, and we want to make sure we weed those out before we ship them to the customer. 1

1 The third thing we do, kind of testing that we 20 do at the component level is to do what we call 21 speed-sorting, to bin them into the different various

1 would assemble it into a PC, and then they test their
2 PCs. So, it's a component of their overall system that
3 they would test.

Q. Okay. Now, how long does the process take from when you've actually got the finished wafer that I've handed you up before to actually getting them out to your customers?

A. The actual component assembly and test process is about two weeks. The module assembly and test
process is about a week and a half. Depending where
you're doing that manufacturing, if -- and wait times
in between, you know, it can be anywhere, if you're in
a hurry, three to three and a half weeks to as many as
six.

15 Q. Okay. Do you ever actually stop production at 16 the fab?

17 A. Not intentionally.

1 Q. So --

A. We try to operate our factory seven days a
 week, 24 hours a day, 365 days a year.

21 Q. You don't close down for the holidays?

22 A. We don't close down for the holidays.

Q. Okay. And you said not intentionally. Has itactually happened, then?

25 A. Yeah, we have had to shut the factory down --

- 1 when I say shut it down, we have had to idle the
- 2 factory. We haven't actually turned the power off,

1 parts of that train.

2	And also, when you're shutting down, it's
3	critical not to leave wafers in certain conditions or
4	in certain process steps, so you have to process them
5	on a little bit ahead to make sure that they're in a
6	state where they can be safe for a couple days.
7	Q. So, what was the actual effect on your
	production of the chips?
	A. With both those shut-downs, you know, we

10 actually idled the factory for one day but lost
11 productivity was on the order of two to two and a half

1 there.

2	What we can control and what we can influence
3	is what it costs us to manufacture those chips, and the
4	lower our manufacturing costs, especially compared to
5	our competitors, the better off we are, and one of the
6	ways we do that is we leverage that \$1 and a half
7	billion investment is by running it constantly. If
	it's sitting there not producing anything, then it's
	costing me money, and I'm getting no return on it.
10	So, that's why it's very important to keep the
11	factory running.
12	Q. And how many chips do you actually produce at
13	the fab a week?
14	A. Given the product mix we're producing today and
15	the production volumes, we produce about 3 and a half
16	million chips a week.
17	Q. And what type of chips are you producing?
1	A. We're producing 256-megabit SDRAM and
1	256-megabit double data rate.
20	Q. Of those 3 and a half million that you're
21	putting out a week, how many of those would be SDRAM
22	and how many at the double data rate?
23	A. Current production quantities, it's about
24	one-third SDRAM and two-third double data rate.
25	Q. Okay, I had something else to show you.
26	

Single Data Rate (SDR) Synchronous DRAM. Page 6 shows
 some product offerings that we have on the Synchronous
 DRAM side.

Q. I'd like you to help me with some of the terms
here. The first column is headed Density. Can you
tell me what that describes?
A. Well, density describes how much memory
capacity the -- in this case the component has. So,
the first one listed there is 128-megabit or it can
store 128 million pieces or bits of memory.
Q. 128 million pieces?

A. Under Package, that's a description of the 1 2 package type, P-TSOP-54 describes an SDRAM TSOP 3 package, and the 54 is how many pins are on that 4 package. Q. Okay. And then Speed? 5 A. Speed is -- you see some things that indicate 6 7 PC100, PC133, PC166. That's an indication of how fast the component will operate. PC100 indicates it will operate at 100 megahertz. PC133 is 133 megahertz and 10 so on. Q. And the next column, Latency? 11 I'm not very familiar with latency. 12 Α. Q. Okay. The part number, I guess that's pretty 13 14 self-explanatory. A. I think somewhere in here, maybe earlier on in 15 the document, it describes how the part numbers -- here 16 17 it is on page 4. It talks about the nomenclature for the part number, and it shows you what each of those 1 pieces mean and how Infineon labels their parts. 1 20 Q. And the Dash Number? A. According to page 4, that's the speed 21 22 performance, so I guess that would be a speed indicator. 23 24 Q. And the Q-Number column? 25 A. I don't know what the Q-number is. 26

Q. And the last column, Production? 1 2 A. There's some -- I guess some acronyms in there under production. It says EOL, which this page 3 indicates means end of life. "Now" I assume means that 4 it's in full production. If you look across to page 7, 5 it's got dates in there, like 3Q 02 would be third 6 7 quarter '02, which I quess is a forecast when these will be available in production. Q. And which of the SDRAMs on this -- these two 10 pages do you actually currently produce at Richmond? A. Just the 256-megabit one at the bottom half of 11 page 6. 12 Q. Do you manufacture all those different types 13 14 and those different organizations and speeds? 15 A. Yes. Q. All right. Now, if you turn back to page 5, it 16 17 seems like a similar kind of diagram, and I won't ask you to go through what these all are again, but what's 1 the -- these concern double data rate Synchronous 1 20 DRAMs, correct? 21 A. That's correct, that's what the header has at 22 the top. Q. Do you manufacture the double data rate DRAMs 23 in this list? 24 25 A. Just the components under 256-megabit, the 26

1 second group down.

2	Q. Does that include the ones that are FBGA?
3	A. No, that's a different kind of package that we
4	don't manufacture in Richmond. We just manufacture the
5	TSOP-66 indicated above.
6	Q. And what does the FBGA stand for?
7	A. BGA is ball grid array.
	Q. Are there any DRAMs that you manufacture at
	Richmond that we haven't talked about in these two
10	pages?
11	A. No.
12	Q. Have you ever heard the term "ramp up" and
13	"ramp down" used in relation to DRAM manufacturing?
14	A. Yes, I have.
14 15	A. Yes, I have. Q. Can you explain to me what those terms mean?
15	Q. Can you explain to me what those terms mean?
15 16	Q. Can you explain to me what those terms mean? A. Well, when you talk about ramping up or ramping
15 16 17	Q. Can you explain to me what those terms mean? A. Well, when you talk about ramping up or ramping down, you're talking about ramping up or ramping down a
15 16 17 1	Q. Can you explain to me what those terms mean? A. Well, when you talk about ramping up or ramping down, you're talking about ramping up or ramping down a product or a technology or or something that you
15 16 17 1	Q. Can you explain to me what those terms mean? A. Well, when you talk about ramping up or ramping down, you're talking about ramping up or ramping down a product or a technology or or something that you intend to sell. When you talk about ramp up, you're
15 16 17 1 1 20	Q. Can you explain to me what those terms mean? A. Well, when you talk about ramping up or ramping down, you're talking about ramping up or ramping down a product or a technology or or something that you intend to sell. When you talk about ramp up, you're talking about going from either no volume in production
15 16 17 1 1 20 21	Q. Can you explain to me what those terms mean? A. Well, when you talk about ramping up or ramping down a down, you're talking about ramping up or ramping down a product or a technology or or something that you intend to sell. When you talk about ramp up, you're talking about going from either no volume in production or a small volume in production and increasing the
15 16 17 1 1 20 21 22	Q. Can you explain to me what those terms mean? A. Well, when you talk about ramping up or ramping down a down, you're talking about ramping up or ramping down a product or a technology or or something that you intend to sell. When you talk about ramp up, you're talking about going from either no volume in production or a small volume in production and increasing the amount that you manufacture or produce, so you would

1 where you go from a very large volume or quantity of 2 production, and you ramp that down either to a very low 3 rate or you ramp it down completely to nothing. 4 Ο. Why do you do ramping up? Well, you would ramp up or ramp down based on 5 Α. what the needs of the customer were. You want to make 6 7 sure that you're producing what the customer wants, so you would want to ramp those products up, if you will, and if there's no more demand for something that you're 10 manufacturing or you've forecasted that demand to go away or you've decided to get out of that business for 11 whatever reason, you would ramp down that product. 12 Q. Does that have an effect on your ability to 13 14 manufacture efficiently by having this ramping process? 15 It can. It depends what you're changing, what Α. 16 you're moving from -- what you're ramping up and what 17 you're ramping down. If you're ramping up and down things that are very, very similar, it would have a 1 1 minimum impact on your factory. If you're ramping up 20 and ramping down two things that are dissimilar, 21 there's big changes, then it may have a major impact on 22 how you go about doing that and what the ramifications 23 are.

Q. Okay. Now, you just -- a moment ago when we were looking at the document I just handed up to you,

1 CX-2466, you mentioned that there's different 2 densities. What do you need to do when you're 3 preparing to start producing a chip at a different 4 density?

A. Well, you have to go in and plan for it for 5 starters. If I -- if I look at what we do at the 6 7 Richmond site, we're not the actually -- we're not actually the first person to do any work on a new part or a new product. We're known within Infineon as a 10 transfer site. Our reference site or the factory that would touch it first has to go in, understand what new 11 things have to be developed, have to be characterized, 12 have to be understood and put in place in order to 13 14 facilitate that new part or that new technology, and 15 they typically work on that for six to nine months before we even see it. 16

Also, up front there needs to be a design done, assuming it's a new part or a new technology, and the design part of our organization, not in Richmond but somewhere else, either in the United States or in Europe, would do the design for that part, and that's a two to four-month process as well.

23 When we get it, we would order masks. When we 24 order masks, an entire mask set takes us anywhere from 25 two to four months to get. We would -- in parallel

with ordering the mask, we would work on the individual process changes that might need to be put in place, if appropriate. We would run silicon through our line. We would get it out. We would electrically test it. We would characterize it. We would understand what worked well in there, what didn't work well. We may have to give feedback to the design organization to make some design changes, get some new masks.

Then we go through what -- a very iterative process, as we make the changes to the mask or we have to make changes to our process to either fine tune or center the processes or make them compatible with one another until we get product out the end that has a sufficient yield that we are comfortable to send it through our back end for a component and module assembly and test.

17 So, ultimately we want to put it through about six to eight weeks of reliability testing to make sure 1 that it meets the reliability expectations of our 1 20 customer. Only at that point will we then send it to 21 the customer for qualification, and depending on the 22 customer, depending on their application, it will take anywhere from one month to five or six months to get 23 fully qualified by the customer. 24

25 And at that point, we would be in a position to 26

1	actually start shipping and to begin the ramp-up, if
2	you will, of that product or technology.
3	Q. So, how long does that whole process take,
4	then?
5	A. Over the last five years, all the technology
6	and product changes we've made at the Richmond
7	facility, we've averaged about 14 months.

1 speed it up, that would take a little bit longer.

2 Q. Okay. How about when you -- you mentioned 3 double data rate SDRAMs, that you manufacture those. 4 What did you actually have to do when you -- to get 5 ready to start manufacturing the double data rate 6 SDRAMs?

A. Well, I know there's some specific processes
that are required for double data rate that don't -that are not required for SDRAM, so we had to develop
those processes. We had to buy some equipment that we
didn't have to perform those processes, so we had to
increase the planning time up front to get that
equipment in. The equipment has a six, sometimes
twelve-month lead time on it.

We have to get the equipment in, start the equipment up, characterize that new process, have it ready for when the silicon gets to that part of the process, and then we would go through the steps I've previously described.

20 Q. And when you say "characterize" the process,21 what do you mean by that?

A. Well, you have to understand the film you're trying to put down. If we go back to the example that -- one of the films we put down on that simple transistor, that film has to be the right thickness, it

has to be defect-free, it has to have the right uniformity all the way across the wafer, it has to have the right etch characteristics, and so you have to run various number of wafers to prove all that out and to characterize that tool, putting down that film, and from an engineering perspective, understand all the nuances and make sure that it's a very robust process that's centered and very stable.

Q. So, for your part of the process for getting ready for DDR SDRAMs, how long did that take? A. It -- I think I said earlier we've been averaging about 14 months. I know that one took two or three months longer.

14 Q. Now, when you get your first mask sets, are 15 those the same mask sets that you'll end up using when 16 you're actually manufacturing the products that you're 17 selling?

A. I've never seen the first one work and not have
 to make changes to it. So, the answer would be no.

20 Q. Do you have an idea of how many you go through,21 how many sets?

A. Each product and technology you change is a little bit different. Typically we'll do at least one all layer redesign, so we'll buy 22 layers, run those, we will find issues, and we will have to do a redesign

1 direction from them on what I need to do or what I need to fulfill from a production schedule standpoint. 2 3 Q. Have you heard of an organization called JEDEC? A. Yeah, I've heard of JEDEC. 4 Q. Do you have an understanding of what JEDEC is? 5 6 A. Yeah, I think JEDEC is an industry-wide standard-setting group that tries to build a consensus 7 across the industry to produce a specification or an industry standard that everybody manufactures and 10 conforms their products to. Q. And do the DRAM -- the DRAMs that you 11

12 manufacture at Richmond comply with JEDEC TnM09(d c)10.n03Aou

1	me, but not just me. They want to be able to buy my
2	parts or Samsung's parts or Micron's part and use them
3	interchangeably, and through the standards process,
4	they get that benefit.
5	Q. Have you ever actually manufactured any parts
6	in the factory that are not JEDEC-compliant?
7	A. I no.
	Q. Do you have an understanding of what Infineon
	produces at its other fabs?
10	A. Yeah, I have a general understanding.
11	Q. Does Infineon, as far as you're aware, produce
12	any SDRAMs or DDR SDRAMs at any of the other plants
13	that are not JEDEC-compliant?
14	A. No.
15	Q. Are you aware of Infineon ever producing a DRAM
16	where it turned out that there was less demand for the
17	DRAM than Infineon was expecting?
1	

1 a couple of customers, but it turned out that the big
2 demand that we thought or wanted to be there didn't
3 exist, and in reality, our customer base really wanted
4 to purchase 128-megabit density. So, we then had to go
5 back and do the work on 128-megabit SDRAM density after
6 we did the 256.
7 Q. 1 Tf9.96 0 0 9.96 90.0002 686.0398 -63 Tc[(]TJ/F2 t0( b)10.9(e)0( sr

build a commodity product, and the fact that we can't 1 2 control the selling price but can only control the 3 cost, that means we have to do a very good job of 4 controlling those costs. We have to be very aggressive to keep those costs down. 5 Secondly, within our industry, over the last 25 6 7 years or so, we have had to -- or our industry has had to reduce its cost per bit or cost per piece of memory by about 30 percent per year just to remain 10 competitive, and so that's always right there at the top of my list of things to work on. 11 Q. And how do you actually go about containing 12 those costs? 13 14 A. Well, we look at all aspects and all contributions to what our costs are, you know, we look 15 at how do we increase our yields? How do we get more 16 17 good chips out for every chip that we start? We look at those things very aggressively. We look at how do 1 we increase our volumes? 1 20 You know, we talked about this huge capital investment that we made, you know, if I can get more 21 22 volume out for that investment, you know, that helps me tremendously with my costs. We talked about running 23 the factory 24 hours a day, seven days a week, 365 days 24

25 a year. We look at how to make the people more

1 64-megabit SDRAM chips at different technologies. If 2 we look at the column on the right, focus over there, 3 the one at the top, you can see that that chip is much 4 larger than the chip below it, which is larger than the 5 chip below it and so on.

6 The top one is built at a 0.24-micron 7 technology, and in parentheses I have tried to indicate -- I have normalized the number of chips that would be on a wafer at 100 percent. As we shrink down 10 from 0.24 to 0.20, we get about 44 percent more chips 11 on that wafer. And if you keep going all the way down 12 to the bottom at 0.17, we get more than two times as 13 many chips as what we started with.

14 Q. Okay.

A. From a -- from a customer standpoint, our customers don't care if they're buying the 0.24 chip or the 0.17 chip, because they all function the same, and he gets the same reliability, same performance, but we care. We would much rather be producing the smaller chip and selling that because our costs are lower. Q. Okay. And what do you actually have to do to

22 prepare to do one of these shrinks?

A. Typically when you do a shrink, you like to do it on a product that you're already producing so that you don't create -- you don't change too many things at

once. So, you would -- for instance, when we went from 1 2 0.24 to 0.20, we did that with the same 64-meg SDRAM. 3 So, we did all of our product learning at 0.24, we had 4 to do all of our process and technology learning at 0.2, but we did it with a product we already knew. 5 So, we probably introduced new equipment, 6 7 introduced new processes, put in the capability to run the wafers. Once again, we processed those wafers, we got electrical performance, we fed that back into both the wafer fab, tweaking the processes. We probably had 10 to tweak the designs, do some redesigns and so on and 11 so forth through that iterative process, and eventually 12 we get all those issues worked out. 13 14 We then build them up into components and modules. We do reliability testing. We send them off 15 to the customer once again for qualification, and then 16 17 they give us feedback some months later. Q. How long does that whole process take? 1 On average, about 14 months for us. 1 Α. 20 You talked about ramping a little bit before. Q. Why do you ramp up rather than just switching straight 21 22 to the new type of DRAM? A. Well, there's -- there's a couple of reasons 23 for that. One, and we talked about the importance of 24 25 cost, so a DRAM factory is always running at full 26

capacity, okay, so there is no extra capacity margin
 there to do extra things, if you will.

The other thing is that any time you make a 3 4 change, you have to do it in a very controlled manner, so when we talked earlier about ramping up, we 5 typically ramp things up over time. So, if we're 6 7 introducing a new part or a new technology, the first time we run that silicon, we do it with a one-of-a-kind equipment set, but quickly we want to add a 10 second-of-a-kind equipment set so we have some flexibility, so if one piece of equipment is down to 11 12 maintenance, we have another route to run that product through that step so it doesn't have to wait. 13 14 As you ramp the production quantities up, you add more and more pieces of equipment, and every time 15 you add another piece of equipment, you have risk, and 16 17 you've got to mitigate that risk. So, what we'll do is we'll run -- we'll take -- the first time we add an 1 extra piece of equipment, we will run a split lot, 1 20 which means that half the wafers will go through a 21 known, good tool and half will go through the new tool, 22 and we will take it all the way to the end of the line to get electrical performance. 23 24 And when we add the third-of-a-kind or

25 fourth-of-a-kind tool, we may add a little more risk

and get close in data instead of going way out to the end, but as we add more equipment, we then take the next step to mitigate our risk by only allowing, say, a third of our production to go through that tool for a period of time until we get enough data or enough history to be comfortable that that tool looks like the previous tool, and then we will eventually turn that on.

And you have to do that very carefully, very 10 purposefully, and it takes time. It takes months to 11 ramp one product from -- to ramp a product or a 12 technology from a low level to a very high level 13 because of those things.

14 Q. Okay. Earlier I believe you said that Infineon 15 has to reduce costs by 30 percent per year. Is that 16 what you said?

A. On average, about 30 percent per year.
Q. Then why do you need to make such big
reductions?

A. That's the -- that's the historical ASP or
average selling price curve that we get for our memory,
and that's been for the last 25, almost 30 years.

Q. So, what happens if you reduce your costs by,say, 25 percent?

25 A. My costs are significantly higher than my

1 competitors, and I slowly go out of business.

Q. Okay. Under what circumstances do you actually
make changes to the DRAMs you produce?
A. There's two kinds of -- generally speaking,
there's two kinds of things that or two reasons that we
make changes. One, we'll make a change -- and we've
talked about it -- to build a product that the customer

wants. You know, we take that input and that feedback from the customer and he tells us what he's interested in buying, and we make changes based on our assessment of that and as we go through our process and our production control system.

13 The other reason that we make process or make 14

1 JUDGE McGUIRE: Yeah, we will have those 2 marked. How do you want to mark those, each one, or do 3 you want to mark them as a group? 4 MR. CATT: Whatever your preference, but I thought we could at least -- we have hard copies of the 5 6 slides we have shown. We could mark that as a 7 demonstrative. JUDGE McGUIRE: Okay. MR. CATT: And then the others we can mark 10 individually. JUDGE McGUIRE: Okay, let's start then with the 11 slides. Do you want to mark them DX-7, I believe it 12 is, at this point? 13 14 MR. CATT: I'm afraid I'm not sure quite where 15 we are. JUDGE McGUIRE: Mr. Stone, is it DX-7? 16 17 MR. STONE: I believe it is, Your Honor. JUDGE McGUIRE: Okay, we will mark those as 1 1 DX-7. 20 (DX Exhibit Number 7 was marked for identification.) 21 22 JUDGE McGUIRE: And how do we want to address these other demonstratives? 23 24 MR. CATT: We can -- I know you said you don't 25 need to keep those, so --26

1 JUDGE McGUIRE: Especially this one. If 2 anything happened, it would take me a long time to pay 3 that off, so... Let's describe, then, these two wafers. Do you 4 want to mark them as DX-8 and DX-9? 5 6 MR. CATT: That would be fine, I think. 7 (DX Exhibit Number 8 was marked for identification.) (DX Exhibit Number 9 was marked for 10 identification.) JUDGE McGUIRE: And I'm sorry, I'm not sure 11 what the terminology is for this particular --12 THE WITNESS: That's a mask. 13 14 JUDGE McGUIRE: That's the mask. We will mark that as DX-10. 15 THE WITNESS: And you're okay, we are not going 16 17 to use that in manufacturing anymore. They wouldn't have given it to me in the first place if they wanted 1 1 it back. 20 JUDGE McGUIRE: No, I feel much better. 21 (DX Exhibit Number 10 was marked for 22 identification.) MR. CATT: I think we also have the block. 23 JUDGE McGUIRE: Yes, we will mark that as 24 25 DX-11. 26

1 proceed?

2	MR. STONE: Maybe since complaint counsel
3	doesn't seem to want them to be part of the record,
4	maybe they should simply withdraw them.
5	JUDGE McGUIRE: I personally don't know why,
6	unless it's been offered and excluded, why anything
7	that's merely been marked needs to be preserved,
	because it won't be part of the record for purposes of
	appeal. Now, that's my interpretation of this. It's
10	only those items of evidence that have been offered but
11	excluded am I obligated to maintain, so if it goes on
1643	appeal, then at that point, that evidence can also be
13	considered, but I don't know what the prior practice is
14	here. So, I think 8 and 9 could be I think withdrawn,
71.56	and that would take care of the problem immediately.
16	MR. CATT: Yes, we will withdraw them, Your
17	Honor.
1	10 10 10JMDGEO MdGU1RE55 70kay, so withdrawn.
1	0 (DX Exhibit Number 8 was withdrawn from the

compiled, and then at that point, we'll put them in a 1 2 box or something and to ensure that they go on down to 3 the Office of the Secretary, and it won't be the 4 obligation of the court reporter to actually have custody of these items. 5 6 So, are we clear on that, everybody? MR. STONE: That makes sense to me, Your Honor. 7 MR. CATT: Yes, Your Honor. JUDGE McGUIRE: Okay, good enough. 10 Then at this time we will proceed with cross examination of the witness. 11 12 CROSS EXAMINATION BY MR. STONE: 13 14 Q. Good morning, Mr. Becker. 15 A. Good morning. Q. Thank you for coming up from Richmond to be 16 17 with us today. We appreciate it. When you first moved to Richmond, who were you 1 1 employed by? 20 A. Motorola. 21 Q. And how long did you continue to work for 22 Motorola? A. I worked for Motorola in Richmond from 1996 23 until the middle of 1999. 24 25 Q. Was the plant that was in Richmond, was that 26

called the White Oaks Plant then? 1 2 A. It was called White Oaks Semiconductor, a joint 3 venture between the two companies. 4 Q. So, Infineon bought out Motorola's interest? A. Yes, they did. 5 Q. That was the summer of '99? 6 7 A. No, they actually concluded the transaction contractually and made payment in April of 2000. Q. Okay. So, the trial you told us about earlier, 10 the trial you sat through in Richmond --A. Yes. 11 12 Q. -- was that -- how long was that after Infineon had for the first time purchased that interest in 13 14 Motorola's plant? A. Well, as I recall, that trial was in April two 15 years ago, so 2001. 16 17 Q. So, they had owned the plant for, what, about a 1 year? 1 A. Wholly owned the plant for about a year. 20 Q. You gave us some dates earlier, and I just want to make sure I can -- I track them on this easel, if I 21 22 can. Tell me when you first started producing silicon. A. Where? 23 Q. In Richmond. 24 25 A. In Richmond? The first silicon came out in 26

1 Q. And every time you shrink it, you have to do a

1 Q. Sure.

A. You need multiple mask sets depending on howmuch volume you're running.

4	Q. Do you remember how many mask sets you
5	needed I know you didn't remember the volume, but
6	A. Well, you always want to have at least two in
7	case you break a mask or you damage a reticle or
	something like that, so at least two, and if you're
	running full volume in the factory, in that time frame,
10	there was probably at least three, potentially four of
11	those mask sets at a time.
12	Q. And for a while, did you run full volume for
13	the 64-meg SDRAM?
14	A. Yes.
15	Q. And what's full volume at the Richmond plant?
16	A. Today, it's about 12,000 wafer starts per week.
17	Q. And how many chips is that?
1	A. With the as I testified earlier, it's about
1	3 and a half million chips per week.
20	Q. Okay. 3.5 million chips per week, right?
21	A. Yes.
22	Q. So, let's go back to this mask issue that you

1 A. Yes.

2	Q. And then you transitioned to the 0.20, and you
3	would have had another two or three full sets of masks?
4	A. Yes.
5	Q. But there would have been a redesign on the
6	0.24 as best you recall, so you would have had another
7	two or three for that?
	A. Well, it depends at what point in your
	qualification, in your ramp you have to do the
10	redesign.
11	Q. Well, I'm
12	A. Typically, you do a full mask redesign as
13	you're going through the learning process up front, so
14	at that point you've got one full mask set, you
15	redesign it, you have another full mask set.
16	Q. Okay. Just give me your best estimate for how
17	many mask sets you would have had during the time, the
1	three years or so, two and a half years, that you were
1	manufacturing 64-meg SDRAM.
20	A. Well, if on average we had three mask sets plus
21	a redesign, that would be four mask sets per, plus some
22	partial redesigns. We're pushing probably the
23	equivalent of five per technology mode. So, at least
24	20 mask sets.
25	Q. Okay, well, let me write down 20 mask sets, and
26	

we understand that's your approximation. 1 Then after you got started with the 64-meg 2 3 SDRAM, which you qualified in August of '98, did you 4 move on to another product? A. Yes. 5 Q. What was that? 6 7 A. Our next product was a 256-meg SDRAM. Q. Okay. And when did you start -- when did you qualify that? 10 A. I don't know an exact date. 11 Q. Can you give me an approximation? 12 A. I think we started work on that in early 2000, sometime -- sometime in early 2001. I would be 13 14 guessing. Q. Is that when it was qualified or when you 15 started production? 16 17 A. Well, I don't know that I --Q. Or are those the same? 1 1 A. I'm not sure how you're using the terms. 20 Q. I was just trying -- earlier you told me you qualified the 64-meg SDRAM in August of '98. 21 22 A. I use the word "qualification" as the culmination of the development process at my site, and 23 at that point, that's a milestone where we've done all 24 25 of our internal work, we've proven it internally, that 26

1	A. General business knowledge and conversations
2	that I have in my day-to-day operation.
3	Q. In your catalog, CX-2466, does this tell us
4	whether the products meet a JEDEC specification?
5	A. I don't know.
6	Q. Does everything in this catalog meet a JEDEC
7	specification?
	A. I haven't looked through the entire catalog.
	Q. Do you know for a fact that everything you
10	manufacture at Richmond meets a JEDEC specification?
11	A. It's my understanding that they do.
12	Q. Do you know it for a fact?
13	A. I I haven't compared a design to a
14	specification, no.
15	Q. Have you ever spoken with Intel about their
16	specifications?
17	A. No, I have not.
1	Q. Do you intend that some of your DRAMs be used
1	with Intel chipsets?
20	A. Yes.
21	Q. And you understand to be used with Intel
22	chipsets, they have to meet the Intel specification,
23	correct?
24	A. One could reach that conclusion. I I you
25	know, I
26	

Q. Do you have enough experience in the field to 1 2 know whether they do or don't? 3 A. I do not. 4 Q. Okay. And do you know whether it's a policy at Infineon that they only make products that meet JEDEC 5 specifications? 6 7 A. I don't know that I've seen a policy that says that. Q. And you know for a fact, don't you, that 10 Infineon manufactures products that don't meet JEDEC specifications? 11 12 A. I think we manufacture a lot of logic parts, 13 for example, that are custom to a customer's 14 application. Q. Well, you manufacture DRAM that doesn't meet 15 any JEDEC specification, don't you? 16 17 A. Me personally in Richmond? Q. No, I mean Infineon, the company. 1 1 A. I'm not sure if we do or don't. I mean, if you're talking about something other than commodity 20 DRAMs now? 21 22 Q. Well, I'm just -- the products in your catalog. Are you familiar with this catalog that Mr. Catt showed 23 you earlier? 24 A. Vaguely familiar. I mean, I can look at it and 25 26

1 talk about it.

2 Q. Is it something you use in the normal course of 3 your business?

A. No, it's not. 4 Q. Well, does everything in your -- in the 5 catalog, all the DRAMs and all the DRAM modules, do you 6 know if they all meet a JEDEC specification or not? 7 A. I think the SDRAM and the double data rate do. I really don't have an opinion on anything else that's 10 in this catalog as to whether it's JEDEC-compliant or not. 11 And you think the SDRAM does because other 12 Ο. people have told you that? 13 14 A. That's right. Q. And -- but you can't tell me what specification 15 it meets? 16 17 A. No, I can't. Q. And as part of what -- the quality control at 1 your plant in Richmond, who's in charge of making sure 1 20 that the products meet a JEDEC specification, if, in fact, they do? Who does that? 21 22 A. Ultimately, that's my responsibility. Q. Well, I mean, don't you have a quality 23 assurance person who has the JEDEC manual and who 24 compares the JEDEC manual and the specifications to the 25 26

products to make sure they meet it? 1 2 A. No, my quality people don't do that. 3 Q. Okay. And it's not important enough that a 4 product meets or doesn't meet a JEDEC specification for a reference to whether it meets or doesn't meet it to 5 show up in this catalog, is it? 6 7 A. I'm not -- please repeat your question. I'm not sure I understand it. Q. Certainly. 10 The catalog doesn't indicate whether a product meets or doesn't meet a JEDEC specification, does it? 11 A. I'd have to look through it in more detail to 12 give you that answer. 13 14 Q. Please feel free if you can do it. A. Okay. (Document review.) I don't see any 15 reference to JEDEC in here. 16 17 Q. Okay. Going back to my little chart, which I guess I should mark as DX --1 1 JUDGE McGUIRE: Twelve. 20 MR. STONE: -- 12 just so we can keep going here. 21 22 (DX Exhibit Number 12 was marked for identification.) 23 BY MR. STONE: 24 Q. Going back to DX-12, in early 2000 when you 25 26

qualified the 256-meg SDRAM, was there a particular
 customer who passed on that product?

3 A. I'm not sure I understand when you say4 "passed."

5 Q. That you qualified it -- earlier you told us 6 you qualified it to meet a customer's specifications. 7 Did I misunderstand?

A. Well, we go ahead and build it to our internal specifications. We have test programs and parametric 10 tests and things like to ensure the quality and the functionality and the performance, and then we send it 11 12 off to the customer, and he does what he does with it, basically puts it into his computer system, goes 13 14 through his internal set of tests, whatever that is, and either validates that it works and performs and 15 functions as it's supposed to or gives us feedback 16 17 otherwise.

Q. Okay. And you still manufacture this 256-meg
 SDRAM that you started in early 2000?

1 A. Yes. 2 Q. So, the plant can make multiple products, 3 right? 4 Α. Yes. Q. Okay. And then have you made any other 5 products besides these two SDRAMs in the plant in 6 7 Richmond? A. For -- yeah, we've made -- historically, we have manufactured some 128-meg SDRAM. 10 Q. Okay, so -- and when did you start the 128-meg SDRAM? 11 12 A. It would have been after the 256-meg SDRAM, so I'd be guessing in 2001. 13 14 Q. Okay. And is that something you're still making today or --15 Not at the Richmond plant, no. 16 Α. 17 Ο. So, that's end of life already? It is for the Richmond plant. 1 Α. 1 Q. How long was the -- how long was the life of 20 the 128-meg SDRAM in the Richmond plant? It was probably a little more than a year. 21 Α. 22 Q. Can I put one-plus year, is that accurate? 23 Α. Yeah. Q. Now, when you told us earlier that you did 24 25 about 12,000 wafer starts a week or 3.5 million chips a 26

week, that depends on the wafer size, doesn't it, the 1 2 equivalency of those two numbers? 3 A. It depends on the wafer size and it depends on 4 the chip size and it depends on the yield. Q. And have you always used the same wafer size in 5 Richmond? 6 7 A. Yes. Q. And that's, what, 300 millimeters? Α. No, it's eight-inch. It's 200 millimeters. 10 Q. 200 millimeters. What's sort of state of the art today in terms of the wafer size? 11 12 A. Our industry is beginning to transition from 200-millimeter to 300-millimeter or from eight to 13 14 12-inch. Q. And is there a plan to do that in Richmond? 15 A. We started an expansion in 2000 to do just that 16 but put it on hold. 17 Q. Okay. Now, in addition to the 64-meg SDRAM, 1 the 256-meg SDRAM and the 128-meg SDRAM, are there any 1 other products that ha6 Tm0 37W90.000f10.9( inAandu)10.9g and from eight to 20

1 way. 2 And when did you start manufacture of that? 3 A. After the 256-meg SDRAM. I -- if we go back, I 4 think we said we started that one in --Q. Yep, we can do that. What you said was early 5 6 2000 for --A. Early 2000, so it would have been middle or 7 late 2000 that we would have started that. Q. So, I'll write mid to late 2000 if that's okay. 10 And that one you're still manufacturing today? A. Yes. 11 Q. And this is the one you told us there was a few 12 extra months it took to get up to speed on that because 13 14 you had to buy some more equipment? 15 A. Yeah. Q. Why did you need additional equipment for the 16 17 DDR? A. It requires additional processes that the SDRAM 1 1 doesn't require. 20 Q. What are those? 21 A. The one I know about sitting here is dual gate 22 oxide. Q. Dual data oxide? 23 24 A. Dual gate oxide as opposed to a single gate 25 oxide.

26

Q. Okay. But there were some other things that it 1 2 needed as well? 3 A. I believe there were, but I can't give you a 4 list. Q. Okay, okay. In what different shrinks did you 5 6 manufacture the 256-meg DDR? A. 0.17 and 0.14. 7 Q. Now, are there any other products that have been -- and just so I'm clear, the DDR was manufactured 10 in the same processing facility as the SDRAM? 11 A. The same factory, yes. 12 Q. Okay. And except for the additional equipment you had to order, it uses the same processing 13 14 equipment? 15 A. Generally the same, yes. Q. Are there any other products that you've 16 17 manufactured in Richmond other than those that we have now listed on DX-12? 1 1 A. No. 20 Q. You told us earlier that building and running a fab plant is very expensive, right? 21 22 A. Yes. Q. And you wouldn't expect a company the size of 23 24 Rambus to be able to afford a fabricating plant, would 25 you? 26

1 A. No.

2	Q. And you the when were you told that a
3	decision had been made to manufacture 256-meg DDR at
4	your plant in Richmond?
5	A. I'm sorry, I don't understand the question.
6	Q. When did you learn from somebody at Infineon
7	that they wanted you to manufacture 256-meg DDR in
	Richmond?
	A. It would have been some months prior to when we
10	started.
11	Q. So, early 2000?
12	A. At least early 2000.
13	Q. And at the time when they told you that they
14	wanted you to manufacture 256-meg DDR at the Richmond
15	plant, did they talk to you about the possibility that
16	based on what they knew then that Infineon's
17	manufacture of DDR at the Richmond plant might infringe
1	on patents owned by Rambus?
1	A. No.
20	Q. Did they ask you to share with them your views
21	as to what it might cost you if you started making
22	256-meg DDR and then were later found to infringe and
23	needed to switch to a product that didn't infringe?
24	A. No.
25	Q. Nobody asked you to do any kind of analysis
26	

1 see the witness here. I can start now. It doesn't --I can go until 1:00 or wait until 1:00, Your Honor. 2 3 JUDGE McGUIRE: Mr. Oliver, any thoughts? MR. OLIVER: Yes, not knowing how long we would 4 5 be this morning, I told Mr. Rhoden to be here at 1:00. 6 JUDGE McGUIRE: I thought you said you saw him 7 here already. MR. PERRY: No, I said I didn't see him. JUDGE McGUIRE: Okay, then let's take a break. 10 It's 20 to 12:00, and let's reconvene at 1:00, then. 11 Off the record. 12 (Whereupon, at 11:40 a.m., a lunch recess was 13 taken.) 14

1 purpose.

2	Now, at that time, in the fall of '98, did you
3	have a leadership position within JEDEC?
4	A. In the fall of 1998, I was a I was chairman
5	of the board of directors, and in the fall of 1998, I'm
6	not sure if I was which committee chair I was. It's
7	possible I was a chairman of one of them. I have had
	many functions off and on with JC-42.3 or JC-42.
	Probably 42.3, which would have been the DRAM

1 McGhee, the JEDEC secretary, and asked him to send on

2 to all JC-42 members?

3

A. It looks like that's correct, yes.

Q. I think I showed you one at your deposition
that was in much smaller type and much harder to read.
It's RX-1118, which I'll show you, if I could, Your
Honor.

JUDGE McGUIRE: Go ahead.

BY MR. PERRY:

Q. And can you just from a rough comparison of the two see that this RX-1118 is the original one that you sent to Ken McGhee and a smaller group of people, and you said, "Could you please forward the attached to the entire membership?"

15 A. Yes, I do.

Q. All right. So, going back to the one that's
easier to read, CX-375, it says in the first paragraph,
it says, "Dear JC-42 Members and Alternates."

1 What is an alternate? What does that mean? 20 A. Well, within JEDEC, every company has one vote 21 that would be represented by the member, a member 22 company, and companies can appoint alternates to the --23 there in place of the member or in addition to the 24 member. It's up to whatever the company wants to do. 25 So, members and alternates all could usually attend,

1 okay?

2	Q. And it's your understanding that the JEDEC
3	office tries to collect email addresses of members and
4	alternates so that they could send out a mass email
5	like this?
6	A. Well, JEDEC office sends it out to a list that
7	has been requested by the companies typically.
	Q. All right. So, the companies ask for
	communications to be sent to certain people, and they
10	provide the email addresses to JEDEC?
11	A. That's correct.
12	Q. Okay. So, you were writing to the JC-42
13	members and alternates.
14	A. That's correct.
15	Q. In the first two sentences it says, "With the
16	successful conclusion of the last meeting, JC42 reached
17	another in a long list of very significant industry
1	milestones. Make no mistake, the standardization of
1	DDR did not come without its own distribution of
20	animated debate and well fought compromise."
21	Do you see that?
22	A. Yes, I do.
23	Q. And what were you referring to by the word
24	"milestone"? What was the milestone?
25	A. We had reached a at the last meeting, the
26	

1 basic feature set had been approved in committee. That 2 would have been the milestone that I would be referring 3 to.

Q. And the basic feature set of what?
A. Of -- oh, of -- and I'm referring here to DDR,
to the DDR SDRAM standard.

7 Q. So, was this memo -- is it fair to say this memo was an effort to recap what had transpired with DDR?

10 A. Reasonably.

11 Q. Okay. Let's look down, if we could, to the 12 bottom of the page, that last full paragraph that 13 starts, "There are several in the industry and some on 14 the committee, who think JEDEC is too slow."

15 Do you see that?

16 A. Yes, I do.

Q. Were you in part writing this memo to respond to some people who were saying JEDEC went too slow in developing standards?

A. I don't think that was my intent. This was adiscussion that has taken place.

Q. All right. Well, you go on to say, "Indeed, we could have finished the DDR standard sooner if only we had started earlier. Let us recap what has transpired with DDR." 1195

1

Do you see that?

2 A. I do.

3 And then you've got some numbered paragraphs, Q. 4 right, or numbered sentences? 5 Α. Yes. Sentence number 1 is, "A lot of private and 6 Ο. 7 independent work outside of JEDEC for most of 1996 (here is where we missed a good opportunity to start early)." 10 What did you mean by "work outside of 1996 --" whoops, sorry, Your Honor. 11 12 What did you mean by "work outside of JEDEC" in 1996? What's that mean? 13 14 A. The feature set that we had been discussing in many meetings throughout JEDEC in -- during 1996, 15 various people had worked -- had taken that feature set 16 17 in pulling it together. Rather than trying to pull the feature set that was under discussion under JEDEC 1 1 during '96, they waited until later to bring these 20 features that had been under discussion in the industry and within JEDEC for -- for, I don't know, for the 21 22 better part of the last decade and put it together and create a codified proposal that would encompass the 23 framework, if you will, of the next generation. 24 25 Q. It's accurate, isn't it, then, that when you

wrote this memo to recap what has transpired with DDR, 1 you didn't start with a lot of work that had gone on 2 3 within JEDEC prior to 1996? 4 A. Oh, that's not true at all, sir. Q. When you wrote this memo, you didn't say 5 anything about the work that had occurred prior to 1996 6 7 within JEDEC that your answer just referred to. Isn't that right? A. Well, I -- I said a lot of private and 10 independent work has gone into creating the -- the collection of features. I did not say anything about 11 where the discussion of those features had taken place. 12 Q. Well, look back at item 1. You just quoted the 13 14 private and independent work part. The next three words are, "outside of JEDEC." 15 So, you did say "outside of JEDEC"? 16 A. Yes, I did. 17 Q. Okay. 1 A. And -- and --1 20 Q. And you didn't talk about the work that had gone on inside of JEDEC before 1996 in this memo. 21 22 Isn't that right? A. I -- correct. 23 Q. Okay. Well, let's move on to item number 2. 24 It says, "December 96 - A single overview presentation 25 26

1 of a DDR proposal at a JC 42 meeting."

2		Do you see that?
3	Α.	I do.
4	Q.	What do you remember what proposal you were
5	referri	ng to, by what company?
6	Α.	Yes, I do.
7	Q.	What company was it?

A. This was the Fujitsu presentation where they had taken a collection of the discussions that had 10 taken place throughout -- in -- within previous meetings for the past decade or so, and they had pulled 11 12 them together in a unified approach to the next generation part. Rather than talking about these 13 features independently, they actually pulled them 14 together, and that is a presentation from Fujitsu. 15 They also happened to coin the name DDR. That's the 16 17 first time that the DDR name shows up, is in the Fujitsu presentation. 1

Q. So, when you wrote this memo, you were trying to say standardization had happened pretty fast. Wasn't that one of your goals in writing this?

A. Well, I was trying -- I was trying to represent some of the things that had taken place, yes. I -- I don't know if I had -- pretty fast was the goal. It was just purely informative. Perhaps pretty fast is

1 one way to look at it.

2	Q. Well, let's talk about that Fujitsu
3	presentation that you were referring to in item 2. You
4	don't say in item 2 that that presentation was a
5	collection of stuff that had been talked about for
6	years. That's not what you say in number 2, right?
7	A. I do not.
	Q. Is it accurate to say that DDR was introduced
	at JEDEC in December 1996?
10	A. No, it's not.
11	Q. All right, I want you to look at RX-911. I'll
12	give you a copy.
13	May I?
14	JUDGE McGUIRE: Yes.
15	BY MR. PERRY:
16	Q. Now, if we could bring up the first page, look
17	at the top. This says, "Why SLDRAM? Desi Rhoden."
1	Do you see that?
1	A. Yes, I do.
20	Q. This is a Power Point presentation you prepared
21	about SLDRAM, correct?
22	A. Yes, it is.
23	Q. It has a date on it that's almost illegible. I
24	believe it says 4/11/97. And if you look on page 3 of
25	this Power Point presentation that you prepared, do you
26	

1 see the heading in the bottom part of the page, the second bullet point, if we could pull that up, the 2 3 second bullet point --4 A. Yes, I do. Q. -- "DDR & SLDRAM were introduced in JEDEC in 5 December 1996." 6 7 Was that an accurate statement when you made it in April 1997? A. The -- the name DDR was created and invented in 10 December of 1996. Prior to that time, we were talking about individual features. The collection of those 11 features into a unified proposal took place in the 12 13 Fujitsu presentation. 14 Q. So, the DDR standardization process actually took about eight years. Is that your testimony? 15 A. Well, it -- it -- if you look at it from the 16 17 individual feature description, perhaps longer than that, but from the presentation of the collection of 1 features -- I'm not sure the question that you're

writing your recap to the JC-42 members back in March 1998, right? 24 25 A. I was looking at it from the collection -- when 26

Q. It's fair to say that you didn't look at it

from the individual feature point of view when you were

1

20

21

22

23

asking me.

1 the presentation was made that was the collection of 2 features, yes. 3 Q. All right, let's go back to CX-375, if we 4 could, which was your March 1998 memo or email to all JC-42 members recapping what had transpired with DDR. 5 6 If you will look at item 3, it's March 1997. 7 Do you see that? A. Yes. Q. And you say, "Many (5 as I remember) 10 presentations of very different proposals at JEDEC 11 (nowhere near the consensus that was supposedly built 12 outside of the -- " and we will go to the top of the next page -- "committee). None of these were 13 14 compatible with each other." Do you see that? 15 A. I do. 16 Q. "At this meeting, the decision was made to 17 finally get serious." 1 Do you see that? 1 20 A. I do. 21 Q. Was that a true statement? 22 A. It was. Q. Let's look at item 4, April '97, the top of 23 page 2. It says, "Real, focused, dedicated work begins 24 25 at a special meeting." 26

1 Do you see that? A. I do. 2 3 Q. And that was true when you wrote that, right? 4 A. Yes. Q. June '97, you say, "First ballots on DDR pass 5 6 committee." 7 Do you see that? A. I do. Q. And moving ahead to September '97, that's when 10 you say, "The diamond in the rough took its basic shape." 11 12 Were you referring to the basic shape of the DDR standard that ultimately was arrived at? 13 14 A. That's correct. Q. Now, I want to --15 First I want to move in, Your Honor, CX-375. 16 17 JUDGE McGUIRE: Any objection? 1 MR. OLIVER: No objection. JUDGE McGUIRE: Entered. 1 (CX Exhibit Number 375 was admitted into 20 evidence.) 21 22 MR. PERRY: As well as RX-911. MR. OLIVER: No objection, Your Honor. 23 JUDGE McGUIRE: Entered. 24 (RX Exhibit Number 911 was admitted into 25 26

1 evidence.)

2	BY MR. PERRY:
3	Q. Now, let's change our focus a bit. That memo
4	was written in March of '98, and I did show you
5	something that referred to SLDRAM. JEDEC was also
6	considering SLDRAM at about that same time period,
7	right?
	A. Yeah, some presentations I think had taken
	place sometime earlier, and it was one of the things
10	under discussion at that time, yes.
11	Q. Can you give us just a minute on what the
12	SLDRAM device was? We've been talking about it some.
13	What was it?
14	A. Okay, the SLDRAM was a was a DRAM device
15	that had independent data and a packet-based address
16	and command, and we showed some of that at the
17	beginning when I referenced the difference between the
1	standard approach versus packet-based kind of where
1	we where you collect address and command packet.
20	Q. You're referring to that demonstrative you went
21	through with Mr. Oliver?
22	A. That's correct, yes.
23	

- 1
- A. It was not.

2 Q. Well, what were the major differences between3 an SDRAM and an SLDRAM?

A. The SLDRAM had a different protocol interface
and a different -- and the interface was quite
different in the way that the signaling took place and
the way operation of the device in terms of how signals
were -- how commands were -- command and address were
packetized, and so that's a different approach.

10 Q. And by being packetized, did you view SLDRAM as 11 being somewhat more similar to RDRAM than SDRAM was to 12 RDRAM?

A. I think the -- that would be generally correct.
RDRAM was packet -- at the time RDRAM was, as I recall,
packet, but it had command, address and data all
together. SLDRAM had command and address packetized,
and then data was -- was separate.

Q. And the SLDRAM technology was being developed 1 within a group called SLDRAM, Inc. Is that right? 1 20 A. Actually, I think it started in the SyncLink consortium and later that became SLDRAM, Inc. 21 22 Q. There was a name change, right? A. Well, no, actually it was formally -- it 23 formally became a corporation when it became SLDRAM, 24 25 Inc. Prior to that, it was just a consortium.

Q. Okay. And the SLDRAM, Inc. became AMI2, right? 1 A. Yeah, as I explained before, we used a 2 3 corporate structure there rather than re-invent it, 4 yes. Q. Right, you did say that. 5 And you went to SLDRAM meetings, maybe not all 6 7 of them, but you did go to some SLDRAM meetings, correct? Α. I did attend some of them, yes. 10 Q. Were you on the board of directors of SLDRAM, Inc.? 11 A. No, I was not. 12 Q. Okay. Did the -- strike that. 13 14 Did you view SLDRAM, the device, as competitive with RDRAM? In other words, was it trying to serve the 15 needs of the same kinds of customers as the RDRAM 16 17 device? A. The RDRAM that I was familiar with at the time 1 was, as I explained, different because address, command 1 20 and data were all on one bus. The SLDRAM had address 21 and command on -- on one collection of lines, and the 22 data on a different. So, it was somewhat different. But could they approach similar customers? I assume 23 they could, yes. 24 25 Q. Well, weren't you present for discussions at 26

1 SLDRAM meetings about how that device would serve the

see that it appears to have been an email sent to you 1 2 and others by Mr. Ford at a PR firm called PRSavvy? 3 A. Yes, I do. And that was SLDRAM, Inc.'s PR firm, correct? 4 Q. A. I believe that is correct. 5 Q. And the story that he sends you and others is 6 7 entitled JEDEC Committee Passes Pinout Proposal for SLDRAM, right? A. Yes, that's correct. 10 Q. And the first -- I'll just read the first sentence of the news story. 11 12 "Memory consortium SLDRAM, Inc. here said the SLDRAM packaging pinout specification has been approved 13 14 by the Solid State Engineering Counsel of JEDEC." 15 (Sic) Do you see that? 16 A. I do. 17 Q. And is it correct that JEDEC did standardize 1 1 the SLDRAM pinout? 20 A. That is correct. 21 Q. Can you briefly describe for us what a pinout 22 is? A. A pinout is a -- I'm going to say a physical 23 representation of the location and the names of the 24 pins, the names of the signals, if you will, for a 25 26

device. So, it's basically a picture of the package
 with the pins labeled.

3 Q. So, in order to produce an SLDRAM device that 4 was compliant with that JEDEC standardization of the pinout, you'd have to conform to the pin locations that 5 were in the standard? 6 7 A. That would be correct, yes. Q. Now, it's true, isn't it, that SLDRAM never disclosed to JEDEC that it had filed patent 10 applications relating to the pinout, correct? A. I'm not sure what -- I believe it was disclosed 11 in the general terminology. I'm not sure specifically. 12 I have -- I have no recollection exactly the specifics 13 14 of whether they disclosed pinout or not. I'm sorry, I can't answer that question. 15 Q. Well, you do know that SLDRAM applied for a 16 17 patent that covered the pinout itself; you do know that. 1 A. I suppose that's possible, yes. 1 20 Q. It covered the actual specifications for the pinout, didn't it? 21 22 MR. OLIVER: Objection, Your Honor, lack of foundation. 23 24 JUDGE McGUIRE: Sustained. 25

1 Honor. 2 BY MR. PERRY: 3 Q. Aren't you a named inventor on the SLDRAM 4 patent that covers the pinout? 5 A. I am a named inventor on several SLDRAM patents, sir. 6 Q. Let me show you Exhibit RX-2086. 7 May I? JUDGE McGUIRE: Please. 10 BY MR. PERRY: Q. You can take a moment. Let's pull up the names 11 12 of the inventors, if we could. A. (Document review.) Okay. 13 14 Q. Are you named as an inventor on this patent, the '644 patent? 15 16 A. It looks like everyone that was present in the 17 meeting was probably named on this patent. Q. Are you named --1 A. And yes, I am named. 1 20 Q. Thank you. 21 In addition, Mr. Kevin Ryan from Micron is 22 named as an inventor on this patent? A. That's correct. 23 Q. He was a Micron JEDEC rep, wasn't he? 24 25 A. Yes. 26

1	Q. And do you see that related U.S. applications
2	go back to August 11, 1997?
3	A. Yes, I do.
4	Q. Do you see that the patent didn't actually
5	issue out of the patent office until August 2002?
6	A. Yes.
7	Q. And sometimes patents take a long time to
	issue, don't they?
	A. True.
10	Q. Well, this patent claims the SLDRAM pinout that
11	was standardized at JEDEC, doesn't it?
12	A. It does.
13	Q. Now, isn't it true that neither you nor any of
14	the other JEDEC representatives that are named
15	inventors on this patent disclosed either an intent to
16	patent the pinout or the fact that a patent application
17	had been filed to cover the pinout during JEDEC
1	meetings in connection with discussions of the pinout
1	standardization?
20	A. I I do not know. I do not remember. The
21	dates for when we standardized and when the actual
22	application was filed are I'm not sure of the work
23	that was taking place at that time.
24	Q. If an application is filed after the standard
25	is passed
26	

1 A. Right.

2	Q and the application claims the exact
3	technology that had been standardized
4	A. Yes.
5	Q and a JEDEC representative is a named
6	inventor on the application
7	A. Yes.
	Q does that JEDEC representative, in your
	understanding of the patent policy, have an obligation
10	to inform JEDEC of the filing of the application even
11	though the standard was passed some time before?
12	A. The the requirement is for disclosure, and
13	the the disclosure of the application is would be
14	necessary during the patent excuse me, during the
15	standardization process. And as I explained earlier,
16	it's my belief that if you fail to disclose it during
17	that period of time, then then you have violated the

Q. Well, let's bring back up your Power Point
 presentation that's 911, RX-911.

3 A. Okay.

4	Q.	Focus o	on the	first	page,	the	bottom	part.	This
5	presenta	ation, e	entitle	ed Why	SLDRAI	M?, Z	you prep	pared,	and
6	it says	, "Indus	stry s	tandar	d inte:	rface	e (no ro	oyalti	es).

A. In this case I was telling it it was no 1 2 royalties. 3 Q. Okay. You didn't use the phrase "reasonable royalties" in that presentation, Exhibit 911, right? 4 You said no royalties. 5 Α. I said no royalties, that's correct. 6 7 Q. And this patent, this pinout patent that's the '644 patent, that has been assigned to AMI2, correct? Α. That is correct. 10 ο. It's now a corporate asset of AMI2, right? A. That is correct. 11 12 Well, let me go back and try to understand the Ο. disclosure issue. 13 14 I think you told us that the disclosure obligation included disclosing technical information. 15 Didn't you say that? 16 17 A. If requested, that's true, yes. Q. If requested? 1 1 A. Well, the -- when a patent is disclosed, you're 20 obligated to disclose sufficient technical information such that a -- such that the IP involved could be 21 22 designed around, and in reality, the way that works is if -- if someone requests that, that's when it's 23 provided. If no one ever requests it, it -- whether or 24 25 not you actually provide the technical information is

1 it to me just now.

2	JUDGE McGUIRE: All right, can we talk about
3	that just for my understanding? I'm not sure I'm clear
4	as to what does it mean when you have your name as an
5	inventor. Does that mean that perhaps you said you
6	didn't even know that your name so, are you
7	THE WITNESS: Well
	JUDGE McGUIRE: perhaps not an inventor? I
	mean, what's the point to this?
10	THE WITNESS: As it turned out in this
11	particular consortium, Your Honor, all of the people
12	that I see listed here were people that were
13	participating in the consortium at the time.
14	JUDGE McGUIRE: Could we put that back up on
15	the screen so I can take a look at that?
16	MR. PERRY: RX-2086, please.
17	THE WITNESS: And you see a long list of people
1	that are named here.
1	JUDGE McGUIRE: Right.
20	THE WITNESS: And the patent applications were
21	handled, as I recall at the time, by SLDRAM, Inc., and
22	there would be filings made. Specifically, this
23	particular filing, pinout or not pinout, I was in
24	terms of did I help invent the patent or did I help
25	invent the IP that is the particular pin location, I
26	

was certainly in the room, and so is -- does that make all of the people that are there and part of the discussion, discussing locations and things? Certainly, you could look at it from that perspective. Did I review the patent or did I review the application? I have no knowledge of reviewing it before --

JUDGE McGUIRE: So, are you saying, then, that because you were in the room, so to speak, that somehow 10 that could be interpreted as you also being a co-inventor of that particular pinout? 11 12 THE WITNESS: Yeah, I -- pinout is pretty 13 simple --14 JUDGE McGUIRE: I'm trying to understand what 15 the correlation is to your involvement with this patent and being in the room, so to speak. 16 17 THE WITNESS: Yeah, the -- I believe all of the people that were part of the discussion to create the 1 pinout are actually named here, because there's a 1 20 number of different companies and individuals involved. I don't know for sure everyone in the room, but 21 22 certainly all of the people that I can remember being there are here. So, I was in the room at the time the 23 discussion was taking place. 24

25 Did I participate? Yes, I participated. I
26

think all of the people that were here had various 1 2 comments. And that's a -- so, were they co-inventors? 3 They were part of the creation of this pinout. So, I 4 assume you can call them co-inventors. 5 JUDGE McGUIRE: All right, Mr. Perry, proceed. BY MR. PERRY: 6 7 Q. Do you understand that inventors have to sign affidavits? A. I do. 10 Q. You signed an affidavit with respect to this particular patent application, correct? 11 12 A. I'm sure I probably did. Q. It states under penalty of perjury or under 13 14 oath that you are, indeed, an inventor of something claimed by this patent, correct? 15 A. Yes, it does. 16 17 Q. You're not denying that you're not an inventor on this patent, are you? 1 1 A. No, I'm not. 20 Q. I think I said that with too many negatives in 21 it. 22 JUDGE McGUIRE: I understand. BY MR. PERRY: 23 24 Q. Do you deny that you're an inventor on this 25 patent? 26

1A. No, I do not deny I'm an inventor on this2patent.

JUDGE McGUIRE: Wait a minute.
THE WITNESS: Let me say it in the positive. I
am an inventor as listed here.
BY MR. PERRY:

7 Q. Thank you.

Well, let's talk about some discussions within SLDRAM about what should be disclosed. I want to show you some of that, and my focus really is on the -- what should be disclosed to JEDEC. That's what I'm going to try to focus on.

13 A. Okay.

Q. So, first I wanted to establish when you started going to SLDRAM meetings, because I think we talked about in the deposition that some of the SyncLink consortium meetings you weren't going to in the '95 to '96 time frame.
A. That's correct.
Q. We established that. And let me just show you

21 a February '97 meeting minute from the SLDRAM

22 Consortium. It's RX-870.

23 May I?

24 JUDGE McGUIRE: Yes.

25 BY MR. PERRY:

1	Q. Now, do you see that this says it's the minutes
2	of the February 11-12, 1997 meeting of the SLDRAM
3	Consortium?
4	A. Yes, I do.
5	Q. Do you see your name is listed for all three
6	sessions?
7	A. I do.
	Q. It seems to be alphabetical. Do you see that?
	A. Yes, I do.
10	Q. And you understood that Mr. Gustavson was
11	taking these notes or minutes at this meeting?
12	A. Yes, I do.
13	Q. That was he was the secretary?
14	A. Yes, that's correct.
15	Q. And just down at the very first paragraph, do
16	you see the word the sentence that starts, "Intel"?
17	Can we bring that up, those two sentences?
1	It says, "Intel wants to come for an hour next
1	time to tell us why they chose Rambus.
20	"Desi: Intel won't change course unless Rambus
21	fails. Don't waste our time if that's all they will
22	tell us at next meeting."
23	Does that refresh your recollection that you
24	were actually at that meeting, February '97?
25	A. Sure.
26	

1	Q. And is it correct that you started attending
2	SLDRAM meetings right about the time that Intel
3	announced that it had selected the RDRAM to be its next
4	generation memory device that it was going to put into
5	

point you to somewhere about two-thirds of the way down 1 to something that's attributed to a fellow named 2 3 Kilmer. I believe that's Art Kilmer. I'll let you find it. 4 Do you see it says, "Kilmer: How do we fence 5 this IP off from Rambus patent pool -- if one company 6 7 is participating in both SLDRAM and Rambus, hard to prevent leaks." Do you see that? 10 A. I do. 11 Q. Now, can you explain to us why there were 12 concerns raised in this meeting about fencing off the SLDRAM intellectual property from Rambus? 13 14 A. I don't think that I can. Q. Okay. The next line says, "We can make this a 15 nontransferable license, our IP can only be used on 16 SLDRAM products." 17 Do you see that? 1 1 A. I do. 20 Q. Was that generally discussed, that concept, at 21 SLDRAM meetings, that the IP, the patents, would be --22 they would be licensed only for use on SLDRAM devices? A. I believe that was a concept that has been 23 discussed, yes. 24 Q. Well, I think that's all I wanted with that 25 26

1 February '97 minutes.

Let's look at July 1997, and on this one I'm afraid I only have one copy, so I'm going to give you my one copy, and then we will look at it on the screen, and I'm going to give counsel time to look at it. I apologize for that. This is RX-966.

7 May I?

MR. OLIVER: Could I take a quick look before

1	Q. Would you look on page 7, please, and let's
2	blow up the picture. It's not you, it appears let's
3	blow up the whole part of it that tells us who that
4	was. Thanks. I was not specific enough.
5	Do you see this appears to be a picture of
6	Larry Bassuk of TI on patent issues?
7	A. I do.
	Q. And he was a Texas Instruments attorney. Is
	that right?
10	A. I believe that's correct.
11	Q. And he came to some SLDRAM meetings?
12	A. I believe yeah, he he was here at this
13	one. I'm not sure how many or if he attended any
14	others or not.
14	
15	Q. And he was an intellectual property lawyer, as
15	Q. And he was an intellectual property lawyer, as
15 16	Q. And he was an intellectual property lawyer, as you understood it?
15 16 17	Q. And he was an intellectual property lawyer, as you understood it? A. As I understood it, yes.
15 16 17 1	Q. And he was an intellectual property lawyer, as you understood it? A. As I understood it, yes. Q. And the first line under his picture is, "Are
15 16 17 1	Q. And he was an intellectual property lawyer, as you understood it? A. As I understood it, yes. Q. And the first line under his picture is, "Are we going to sue anybody?"
15 16 17 1 1 20	Q. And he was an intellectual property lawyer, as you understood it? A. As I understood it, yes. Q. And the first line under his picture is, "Are we going to sue anybody?" Do you see that?
15 16 17 1 1 20 21	Q. And he was an intellectual property lawyer, as you understood it? A. As I understood it, yes. Q. And the first line under his picture is, "Are we going to sue anybody?" Do you see that? A. Yes, I do.
15 16 17 1 1 20 21 22	Q. And he was an intellectual property lawyer, as you understood it? <ul> <li>A. As I understood it, yes.</li> <li>Q. And the first line under his picture is, "Are</li> </ul> we going to sue anybody?" <ul> <li>Do you see that?</li> <li>A. Yes, I do.</li> <li>Q. Let's pull it out and see a little bit more, if</li> </ul>
15 16 17 1 1 20 21 22 23	Q. And he was an intellectual property lawyer, as you understood it? A. As I understood it, yes. Q. And the first line under his picture is, "Are we going to sue anybody?" Do you see that? A. Yes, I do. Q. Let's pull it out and see a little bit more, if we could. No, forget the picture, if we could go down

1 to be prevented from using our own technology."

2 Can you explain to us what concept was being 3 discussed that mainly SLDRAM wanted to have patents so 4 it wouldn't be sued? Yes. 5 Α. Q. Explain that. 6 7 A. Well, I'm not sure that I can. I can give you my opinion, if you like. Q. Well, I'm really looking for your understanding 10 from being at the meetings, but if you can't remember -- I don't want you to just base it on the 11 words in the document. 12 13 A. Okay. 14 Q. If you have an independent recollection of 15 being in these SLDRAM meetings and what people were talking about in terms of using the patents to avoid 16 17 being sued, tell me that. A. I -- I don't have a specific recollection about 1 1 that particular aspect, about -- I mean, there was some 20 discussions about it when Mr. Bassuk came. 21 Q. Well, and then do you see down a little bit 22 further, it says, "DR: No, we do wish to stop nonmembers from using this." 23 24 Do you see that? A. Yes, I do. 25 26

1 BY MR. PERRY:

-	
2	Q. And page 2 is where the text begins, and I'm
3	focused on the part of the email chain that is in the
4	lower half of the page 2, and if you could just confirm
5	that you're listed as one of the recipients on this
6	email from Mr. Bassuk, B-A-S-S-U-K, the lawyer from
7	Texas Instruments.
	Do you see that?
	A. Yes, I do.
10	Q. And it's entitled, "Email to SLDRAM" pardon
11	me. "Email to SLDRAM members for patents."
12	Do you see that?
13	A. I do.
14	Q. Mr. Bassuk says, "SLDRAM, Inc. needs to file
15	some patent applications to protect your investments in
16	time and money. Primarily, these patents will be
17	defensive to protect your right to do business, to
1	make, use and sell SLDRAM products. These patents will
1	also help us encourage competing non-members to join
20	SLDRAM, Inc. "
21	Do you see that?
22	A. Yes, I do.
23	Q. Now, did you have an understanding in June 1998
24	when you got this email from Mr. Bassuk how SLDRAM's
25	patents could be used to encourage nonmembers to join
26	

1 SLDRAM?

2	A. Well, I'm not sure that I that I actually
3	read this from Mr. Bassuk. I was not in the habit of
4	reading his particular email, but I did have an
5	understanding of the some of the words that he uses
6	here, defensive, so that we could make and sell the
7	devices. That I do remember.
	Q. Now, at that time, in June '98, you held
	leadership positions at JEDEC, right?
10	A. I did.
11	Q. And you saw from this email that SLDRAM had
12	identified about 50 patentable inventions that's
13	what it says there, right?
14	A. I believe that's correct.
15	Q. Did it occur to you that given that there were
16	parts of the SLDRAM device that were going through the
17	standardization process at JEDEC, that there ought to
1	be a review of those 50 patentable inventions to see if
1	any of them related to the work of JEDEC?
20	MR. OLIVER: Objection, Your Honor, assumes
21	assumes facts not in evidence. So far, the only facts
22	in evidence are that the pinout was a JEDEC
23	standardization.
24	JUDGE McGUIRE: Mr. Perry, a response?
25	MR. PERRY: Well, Mr. Oliver took the witness
26	

through various SyncLink presentations that were made at JEDEC on day one of the direct examination with the inference that Rambus was supposed to stand up and say it had intellectual property with respect to those various SyncLink presentations in 1995, and some of these patents fall from those presentations, Your Honor.

MR. OLIVER: Your Honor, those presentations are dated from 1995. This relates to 1998. There is a 10 significant difference in the work that was going on within JEDEC over those three years. 11 12 MR. PERRY: There was also -- we can go through the minutes and find the reference to the SLDRAM bits 13 14 and pieces that were being standardized. 15 JUDGE McGUIRE: All right, I am going to overrule the objection and allow you an inquiry into 16 17 that if you go back into redirect, Mr. Oliver. MR. OLIVER: Thank you, Your Honor. 1 JUDGE McGUIRE: You may answer the question if 1 you still understand the question, Mr. Rhoden. 20 MR. PERRY: It was a long question. Can we 21 22 have it read back? THE WITNESS: Perhaps we can read it back. 23 24 JUDGE McGUIRE: Yes, court reporter. 25 MR. PERRY: Thank you.

1 (The record was read as follows:) 2 "QUESTION: Did it occur to you that given that 3 there were parts of the SLDRAM device that were going 4 through the standardization process at JEDEC, that 5 there ought to be a review of those 50 patentable 6 inventions to see if any of them related to the work of 7 JEDEC?"

THE WITNESS: The -- did it occur to me that we should review these at the time? Right -- at the -the 50 were just proposals, I believe, that came from I would assume Mr. Bassuk. I'm not sure where they came from. And the -- the review of that, I believe that it would be more applicable to review what ultimately was filed, because anything not filed obviously is in the public domain, I would expect.

16 So, I believe, as I say, that SLDRAM made the 17 representation that they intended to follow the JEDEC 1 patent policy with all of the IP that was created in 1 association with this device at this time.

```
20
```

BY MR. PERRY:

21 Q. You may recall that on Friday we were talking 22 about the letter from Secretary Clark of the FTC in 23 June of 1996.

24 A. Yes.

25 Q. And there's a sentence in there about --

something like the important thing is that the patented technology is available on a reasonable and nondiscriminatory basis, and I asked you if that was the important part of the JEDEC patent policy as well, and as I recall it, you said that disclosure of the technical details was also important.

7

Do you have a memory of this discussion?

A. I believe what I said was that disclosure of the intellectual property during the standardization
process was the -- from my perspective the most
important.

Q. Now, you know, don't you, that some of the ideas that developed out of SLDRAM, some of those patentable inventions were then incorporated into the DDR II standard, weren't they?
A. I'm not sure. I do not know whether they were

17 or were not.

Q. Did you ever look to see if any AMI2 patent --1 1 correct?

A. In that time frame, that's reasonable, yes. 2 3 Q. That's at the 42 committee level, right? 4 MR. OLIVER: Objection, Your Honor, if I could ask for a clarification. My understanding is the work 5 went on for some period of time. Are you referring to 6 7 the time period in which it was completed or are you referring to another time period? MR. PERRY: I was going to try to get the 10 witness to explain, but what I was talking about was --JUDGE McGUIRE: Well, he can't explain what 11 you're talking about. You need to explain what you're 12 talking about. 13 14 MR. PERRY: I'll get there. I'll try to get there, Your Honor. 15 BY MR. PERRY: 16 17 Q. There was a point in time at which the JEDEC 42 committee approved preliminary specifications for the 1 1 DDR II device, correct? 20 A. That's correct. Q. And that was sometime in the summer of 2001, 21 22 wasn't it? A. That sounds reasonable, I believe. 23 Q. And up until that point, there were various 24 25 bits and pieces of that specification that were going 26

through the approval process within the 42 committee, 1 2 correct? 3 A. For a long period of time, as we discussed. 4 Q. Well, let me show you an AMI2 memo dated March 12, 2001. It's RX-1773. 5 6 May I? 7 Now, this is an email and some attachments that appear to have been sent by someone named Lisa Rhoden. That's your wife, right? 10 A. That is correct. O. And she worked for AMI2 at the time? 11 12 A. Yes, I believe she did. Q. And it says, "Dear AMI2 Executive Members." 13 14 Is this something that she sent to the AMI2 executive members in March 2001? 15 A. That would be correct. 16 17 Q. And I think we established on Friday the executive members were all DRAM manufacturers. Is that 1 1 right? 20 A. I believe that's correct, yes. 21 Q. And it's entitled Patent Summary Presentation. 22 It says, "Attached is a presentation that Desi and I created which contains a more concise summary of the 23 24 patents issued to and filed by AMI2." 25 Do you see that? 26

1 A. Yes.

2	Q. Now, it's correct, isn't it, that all the
3	patents held by AMI2 came out of the work done at
4	SyncLink and SLDRAM, correct?
5	A. That's correct.
6	Q. AMI2 has been more of a marketing-focused
7	organization. Is that right?
	A. As I said before, AMI has been coordinating.
	Marketing is one of the things, but coordinating
10	infrastructure development is the primary focus of AMI.
11	Q. And AMI inherited, as it were, or had in its
12	corporate assets the patent portfolio of SLDRAM, Inc.,
13	right?
14	A. As a result of inheriting the name
15	inheriting the corporate identity, yes, that is
16	correct.
17	Q. And the presentation is entitled Patent
1	Portfolio Update, if you see on page 2.
1	Do you see that?
20	A. I do.
21	Q. The third page says, "AMI has been pursuing a
22	number of patents for several years."
23	Do you see that?
24	A. I do.
25	Q. And then there's the next page, page $4$
26	

I'm sorry I'm going so fast, but on page 4, it's 1 2 entitled Legal Rights. It's a presentation that you 3 and Ms. Rhoden put together. It's entitled Legal Rights, correct? 4 A. I do. 5 Q. And it says, "All patents are filed under the 6 7 corporate entity, AMI." They are all assigned to AMI. Then it says, "Current Executive members have rights to use all patents for all products." 10 Do you see that? A. I do. 11 And those are the DRAM manufacturers that are 12 Ο. the executive members of AMI, correct? 13 14 A. That's correct. 15 Q. And, "By individual company agreement, current adjunct members have access to the patents for 16 17 everything except the manufacture of memory devices." Do you see that? 1 1 A. I do. 20 Q. And does that mean that if you were an adjunct member of AMI, you couldn't use the AMI patents to 21 22 manufacture memory devices? A. Well, the -- the adjunct members, since they 23 were not memory manufacturers, would have no reason to 24 25 do so, and -- but your statement in its face value was 26

correct, but they were not in the business of 1 2 manufacturing memory, so they would have no reason to 3 ever use them for that. 4 Q. If they wanted to get into the manufacturing business, they couldn't -- at least under the current 5 state, as of March 2001, they couldn't use the patents 6 7 to do that? A. Well, they certainly could pay the same fees that the executive members paid and use the patents. 10 No problem. Q. And then on the next page, this would be page 5 11 of the exhibit, there's three patents listed as issued. 12 Do you see that? 13 14 A. I do. Q. And those patents were all filed in September 15 '97, and two of them issued in 1999, and one in 2000, 16 17 right? A. Yes, that's correct. 1 1 Q. And then there's another list on the next page 20 of patents allowed awaiting issue, and then if you'll turn to page 7, you'll see patents still pending. 21 22 A. Yes, I do. Q. Now, one of them, the second one, "Memory 23 System Having Synchronous Link DRAM (SLDRAM) Devices," 24 25 that's the pinout patent, right, which you were an 26

1 inventor on?

2 A. I do not know.

3 Q. Do you have the patent in front of you?

A. Okay.

5 Q. The '644 patent. It's got the same title, 6 doesn't it?

7 A. I see it, yes.

Q. Did AMI have two patents in its portfolio with the same name?

A. I'm not sure. I was not responsible for
managing the portfolio. It is possible that this is a
piece of that or a divisional or I have no idea. This
may be the only one. I do not know, sir.
Q. The cover memo had said this presentation was
put together by you and your wife.

16 A. That's correct.

Q. Did you play any role in putting it together?
A. I played a role in helping her put it together,
yes, I did.

20 Q. By this time, had you looked at the patents in 21 the portfolio?

22 A. I had not.

Q. By this time, did you know that your name wasan inventor on any of them?

A. I knew my name was an inventor on some of them,

1 because I had participated in -- during the time that

2 the development work was going on, and I had signed

1	true.
2	Q. Well, let me show you let me show you a
3	letter signed by you dated July 4th, 2001, RX-1858.
4	May I?
5	JUDGE McGUIRE: Go ahead.
6	BY MR. PERRY:
7	Q. You wrote this to JEDEC, correct?
	A. I did.
	Q. It says, "Attention: John Kelly and Ken
10	McGhee."
11	Mr. Kelly was the president of JEDEC, right?
12	A. That's correct.
13	Q. Mr. McGhee was the secretary, right?
14	A. That's correct.
15	Q. It says, "Re: AMI Patents and Patent
16	Applications."
17	Do you see that?
1	A. I do.
1	Q. And this letter contains a list of patents
20	issued to AMI, patents allowed awaiting issue and
21	active patent applications pending.
22	Do you see that?
23	A. Yes, I do.
24	Q. In the first paragraph on the first page, we
25	will pull that up, the second sentence says, "As
26	

1 virtually all of AMI's patents and applications relate to memory and memory sub-systems, it is possible that 2 3 these patents or applications may apply to items 4 including DDR II currently under consideration in 5 JEDEC." 6 Do you see that? A. I do. 7 Q. Had anyone done any analysis of the -- any of the patents or applications to see if, in fact, they 10 did relate in some general way to any of the DDR II specifications? 11 12 A. Not to my knowledge. I have not. Q. Why did you wait until a month after JEDEC 13 14 completed the balloting and approval within the 42 committee of the preliminary spec for DDR II before 15 disclosing to JEDEC the patents and applications listed 16 17

A. That -- that the -- it is the stated policy of AMI that they would follow the JEDEC patent policy, yes, that's correct.

Q. But this is the very first time the existence
of these patent applications was disclosed to JEDEC.
Isn't that correct?

A. I don't believe so, sir, no. The -- the patent 7 application -- the -- it was -- it has been disclosed, previously discussed, that everything that was there 10 was available and would be available -- would be made 11 available on reasonable and nondiscriminatory basis. The letter itself -- this is -- this is the assurance 12 letter, and the only reason that I filed it at this 13 14 time is because I became aware that it had not been previously filed by my predecessor in the then SLDRAM, 15 Inc. 16

I was under the impression that it had already been sent to the JEDEC office, and so someone brought it to my attention -- I don't remember who -- that they did not have a letter on file, and so I provided this letter in that time frame.

Q. You understood in that time frame that if someone wanted to use technology contained in the patent applications or patents to build non-compatible devices, in other words, to build memory devices that

1 were not SLDRAM, that they would need a license from
2 SLDRAM, from AMI?
3 A. Did I understand that?
4 Q. Yes.
5 A. No, I understood that we had filed -- we had
6 committed to JEDEC that we would follow the JEDEC
7 patent policy. That's what I understood.
Q. Isn't it true that in the March 2001 memo,
adjunct members didn't have access to the patents to

A. I do not know. 1 2 MR. PERRY: Your Honor, could we take a short 3 break? 4 JUDGE McGUIRE: Okay, yeah, we'll break for ten 5 minutes. 6 MR. PERRY: Thank you. 7 JUDGE McGUIRE: Thank you. (A brief recess was taken.) JUDGE McGUIRE: On the record. 10 Mr. Perry, you may proceed with your cross examination. 11 12 MR. PERRY: Thank you, Your Honor. BY MR. PERRY: 13 14 Q. I want to change focus now and talk about what you understood about Rambus' intellectual property in 15 the same time period that we've been talking about. 16 17 That's going to be the focus of these questions, and I'm still going to be focusing on SyncLink and SLDRAM 1 meetings while discussions were being held there. I'm 1 20 just giving you a little introduction. 21 Now, we saw that you were attending SLDRAM 22 meetings at least by February of '97, correct? 23 A. Correct. Q. I want to show you some minutes that were from 24 a meeting you didn't attend, and I can represent for 25 26

```
the record that there will be testimony in this
1
      proceeding that members did have access to earlier
2
3
      minutes, and I'll just see if he's seen them or not or
      if he heard some of the statements. Let me start with
4
      Exhibit 589, RX-589.
5
6
              May I?
7
              JUDGE McGUIRE: Go ahead.
             BY MR. PERRY:
          Q. Now, these purport to be minutes of a SyncLink
      meeting from August 21, 1995. Do you see that?
10
```

Rambus informed us that in their opinion both RamLink 1 2 and SyncLink may violate Rambus patents that date back 3 as far as 1989. Others commented that the RamLink work 4 was public early enough to avoid problems, and thus might invalidate such patents to the same extent that 5 they appear to be violated. However, the resolution of 6 7 these questions is not a feasible task for this committee, so it must continue with the technical work at hand." 10 Do you see that? A. I do. 11 Q. Now, at any point in time when you were going 12 13 to -- later on, when you were going to SLDRAM meetings, 14 were you present for any discussions about any concerns 15 about SLDRAM avoiding infringement of Rambus intellectual property? 16 17 A. I -- I don't have a recollection about that. It's possible. 1 Q. Do you remember people talking in SyncLink 1 20 meetings, in SLDRAM meetings, about Rambus patents or 21 about Rambus intellectual property? 22 A. I don't recall, sir. Q. When you started going to SLDRAM meetings, you 23 were representing your company, right, VLSI? 24

25 A. That's correct.

Q. Did you do anything on behalf of VLSI to try to 1 determine whether or not the SLDRAM device did or did 2 3 not infringe on anybody's intellectual property? 4 A. I did not. Was there someone on behalf of SLDRAM whose job 5 Ο. it was to try to avoid infringement of intellectual 6 7 property in the memory manufacturer or design area? A. I do not know. Q. All right, well, let's look at some additional 10 minutes. I'll show you CX-488, which is January 1996, if I could approach. 11 12 JUDGE McGUIRE: Go ahead. BY MR. PERRY: 13 14 Q. Now, again, Mr. Rhoden, this is before you 15 started going, and I want you to know that right up front, but if you look on the second page, it says, 16 "Minutes of January 11, 1996 meeting of the SyncLink 17 consortium." 1 1 Do you see Kevin Ryan and Terry Walther from 20 Micron are listed as being there? 21 A. I -- yes, I do. 22 Q. And they've been to a lot of JEDEC meetings that you've seen, correct? 23 A. They have. 24 25 Q. And Mr. Crisp is no longer listed here, right? 26

```
1
          A. I do not see his name, no.
2
          Q. Okay. Let me just point you to the first
3
      paragraph, and I'll ask you if you've ever seen or
      heard this before, if we could pull that up.
4
5
              It says, "Rambus has 16 patents already, with
6
      more pending."
7
              Do you see that?
          A. I'm -- which page?
          Ο.
              I'm sorry, I'm on page 2.
10
          Α.
              I have a page 2, and my page 2 --
          Q. First paragraph?
11
12
          A. Oh, it says comments -- oh, I see, never mind.
      Thank you.
13
14
          Q. "Rambus has 16 patents already, with more
      pending."
15
              Do you see that part?
16
          A. I do.
17
          Q. Then it says, "Rambus says their patents may
1
1
      cover our SyncLink approach even though our method came
20
      out of early RamLink work."
21
              Do you see that?
22
          A. I do.
          Q. Have you ever seen this page of these minutes
23
      before?
24
25
          A. I have in my deposition, yes.
26
```

Q. Putting aside your deposition, have you ever seen -- before this lawsuit was started, have you ever seen this page of these minutes?

A. I don't recall ever having seen this, no, sir.
Q. When you started going to SLDRAM meetings, did
you get any kind of collection of official documents,
minutes, policies, bylaws?

A. I -- I did not get any meeting minutes. I'm not sure if I got anything else. It's possible I got
some other stuff, but I don't recall.

Q. Did somebody say, we've been meeting for a year or two, and the minutes are available if you want them? A. I never asked the question. I don't recall anybody having said that.

Q. Well, looking at this, does this at all refresh your recollection that there was some discussion in your time period, when you were going to meetings, of Rambus' intellectual property?

A. I have no recollection.

20 Q. Now, going back to how you understand the 21 operation of the JEDEC patent policy, did the -- did 22 any of the JEDEC representatives in the room at these 23 meetings, putting aside Mr. Crisp for the moment, did 24 any of them have any obligation, as you understand the 25 operation of the JEDEC patent policy, to tell JEDEC

26

1 about any of the statements that were being made in the 2 August '95 meeting or the January 11, '96 meeting? 3 MR. OLIVER: Objection, Your Honor, lack of 4 foundation. He has testified he was not present for the meetings and did not see the minutes before the 5 litigation. 6 JUDGE McGUIRE: Sustained. 7 BY MR. PERRY: Q. Let me ask you to assume that the statements 10 recorded in the minutes were made at the meeting in 11 front of these gentlemen who were JEDEC representatives. 12 As you understood the operation of the JEDEC 13 14 patent policy in late '95 and early '96, were any of those representatives obligated to tell JEDEC about the 15 statements that had been made? 16 17 MR. OLIVER: Objection, Your Honor, lack of foundation. The witness has no idea of the context in 1 which any of these statements reflected in the minutes 1 20 were given or if they were accurate. 21 MR. PERRY: He can tell me he doesn't know, but 22 he was a member of this organization, and he's testified about the state of mind that he believes a 23 JEDEC representative needs to have before a disclosure 24 obligation is triggered, and I'm just trying to find 25 26

1 out if in his view that it applies to this.

2 JUDGE McGUIRE: Sustained.

3 MR. PERRY: All right.

4 BY MR. PERRY:

5 Q. Let's try it a different way, Mr. Rhoden.

6 If you had been present in a SyncLink or SLDRAM 7 meeting, putting aside these minutes, and you had heard someone say that Rambus had intellectual property claims with respect to a certain feature,

10 understanding -- with your understanding of the JEDEC 11 patent policy and the SyncLink bylaws, is there 12 anything in the SyncLink bylaws that would have 13 prevented you from making a statement at JEDEC about 14 what you heard about Rambus' intellectual property?

15 A. First, there is nothing that would have prevented me from reiterating a rumor, and I think 16 17 that's what you're referring to, because I mean this is -- this would be I've heard that such and such may 1 1 be true. There wouldn't be anything that would prevent 20 you from saying something like that. I'm not -- I'm 21 not aware of anything that prevents you from saying 22 whatever you want.

23 Q. Okay, thank you.

Now, let me show you the December '96 meeting
minutes from the SyncLink Consortium just to provide

1	Q. Up above that, it says something about
2	suppliers being paranoid. Do you see that? Does that
3	refresh your recollection?
4	A. I do not recall if this was my first meeting or
5	not, sir.
6	

1 the January 14 to 15, 1997 --

2 A. Yes, I do.

3	Q SLDRAM meeting?
4	There's a reference in the first line to a
5	Tokyo meeting of executives. Did you attend the
6	meeting of SLDRAM company executives in Tokyo in 1997?
7	A. I don't believe I did.
	Q. If we could talk about some of the intellectual
	property issues on page 6. Let's pull up the first ten
10	lines or so starting with, "Desi: 4 questions." It
11	says four questions, but I see five listed. If you
12	could read that to yourself, those five questions.
13	A. (Document review.)
14	Q. Do you see after the questions there's a
15	statement attributed to FT?
16	A. I do.
17	Q. And you understood when you were reading these
1	minutes that FT was a reference to Mr. Tabrizi?
1	A. It's possible.
20	Q. Do you see that one of the things listed in
21	that statement is, "Consider Rambus patent issues"?
22	A. Yes, I do.
23	Q. Does that refresh your recollection that there
24	was discussion in the January '97 or any other SLDRAM
25	meeting that you were present for about Rambus patent
26	

1 issues?

2	A. I don't I don't recall, sir.
3	Q. Then it says, "Need to file patents daily!"
4	Was there an emphasis within SLDRAM, Inc. of
5	filing patents on the ideas that were being discussed?
6	A. I don't recall a specific interest. I mean,
7	I'm sure people made particular statements about
	patents, but I myself don't recall it being either
	significant or memorable.
10	Q. There was a company called MOSAID, M-O-S-A-I-D.
11	A. MOSAID.
12	Q. MOSAID, and they were designing the SLDRAM
13	device under contract with SLDRAM, correct?
14	A. I think that's partially correct.
15	Q. And do you remember discussions about having
16	MOSAID do a prior art search or do a patent search to
17	determine whether or not the device it was designing
1	would infringe Rambus patents?
1	A. I don't recall that particular discussion, no.
20	Q. Well, let me point you to one more set of
21	minutes on that issue. This will be RX-966.
22	May I?
23	JUDGE McGUIRE: Go ahead.
24	BY MR. PERRY:
25	Q. And do you see that you're listed as being
26	

1 Consortium"?

2	A. I can speculate, but I have no direct idea.
3	Q. Did you talk to anyone at VLSI, your employer,
4	in the '97 time period about the possibility that
5	Rambus might sue VLSI?
6	A. I did not.
7	Q. Do you remember a discussion at the end of

which the SLDRAM Consortium or SLDRAM, Inc. decided not

and -- I think that's 18, it's a typo -- and Friday,
 September 19, 1997 meeting?

A. It says 17 and 19, but I assume it's 18-19.
Q. All right. You'll see you're listed as being
in attendance?

6 A. I do.

7 Q. I am going to point you to a discussion at the bottom of page 4 of the minutes, and there's a reference to someone named JK or whose initials might 10 be JK, and it says, "There was discussion yesterday on 11 bylaws, whether incorporation resolved IBM's concerns 12 or not; indemnification issue;" then it says, "Art: Need MOSAID -- MOSAID -- to guarantee best effort not 13 14 to use others' IP. Just want same guarantee one always 15 gets from a supplier." If you look at the top of the next page, 16 17 there's -- do you see there's something attributed to you that says, "Let the legal staffs work this out, 1 move it outside this meeting"? 1 20 A. Yes, I do. Q. Do you remember saying that in this discussion? 21 22 A. I -- I don't remember specifically this case, but it would be something I would normally say, yes. 23 24 Q. Well, look down a little bit further to a 25 reference to somebody named Chad Mar. 26

1	that?
2	A. I think so, yes.
3	Q. Was that something you prepared yourself or did
4	you review it after it had been prepared?
5	A. I reviewed it after it had been prepared.
6	Q. Now, did you know when you were testifying
7	Thursday who had prepared it?
	A. No, I did not.
	Q. Are you aware that it was Hynix who prepared
10	it?
11	A. As I said, I don't know who prepared it. I
12	have no knowledge.
13	Q. Did you intend to suggest through your

Q. Were there any Hynix lawyers in the room back 1 2 at HP in '90 or '91 when you were hearing that 3 presentation? 4 A. No, there were not. Q. And you didn't play any role in preparing the 5 presentation that was given, right? 6 7 A. I did not. Q. Did you give any instructions to whoever prepared it about what to include in the description of 10 RDRAM? A. I did not. 11 12 Q. All right. I want to talk a little bit about the patent tracking list just for a moment. We've 13 14 talked about this before. If we could bring up RX-559 just as an example. This one's in evidence already. 15 We talked about this before. 16 17 Let's go to page 4. This is the May '95 patent tracking list that was put up at meetings. Here's my 1 1 question: Do you remember being present the very first 20 time that Mr. Townsend showed a patent tracking list at a JC-42 meeting? 21 22 A. I am not sure if I was present the very first time. I was certainly present during many patent 23 tracking applications. I can't say for certain that I 24 25 was there at the very first time. 26

1	Q. The very first time, did he have some
2	explanation about this is something now and why he's
3	doing it, something that explained why this was
4	suddenly being used? Do you remember that?
5	A. I don't recall a particular explanation for
6	this is why I'm doing this for the first time. As I
7	recall as I said, I don't have a particular
	recollection of a first time.
	Q. Okay, well, let's
10	A. I have seen this many times.
11	Q. I didn't mean to interrupt you.
12	Let's look at the December '91 minutes. That's
13	JX-18. Those are also already in evidence. If we
14	could make it a little bigger to see if Mr. Rhoden's
15	name is there.
16	Do you see you're down at the bottom for VLSI?
17	A. Yes, I do.
1	Q. That can't be December '91, though, if you were
1	for VLSI. That's got to be
20	A. No, this can't be December 1991. I was not at
21	VLSI at that time.
22	Q. Let me figure that out, Mr. Rhoden.
23	A. It looks like December 1993.
24	Q. Oh, it's JX-10 that we want. I got my
25	Decembers mixed up.
26	

- 1 A. Okay.

2	Q. Let's look at JX-10, the first page. Now, this
3	says December 1991, and let's see if we can find you as
4	Others Present, do you see that, for Hewlett Packard?
5	A. Yes, I do.
6	Q. All right. Now, let's look at page 11, and
7	let's look at something under Patent Matters. Why
	don't you pull up that first paragraph under Patent
	Matters. That says, "Mr. Townsend presented the patent
10	policies and a list of patents identified."
11	Do you see that?
12	A. I do.
13	Q. "TI" that's Texas Instruments? You think?
14	A. I believe so.
15	Q. " asked what the purpose of the list was.
16	The purpose was only to track and identify patented
17	items of Committee proposals. Companies who hold
1	patents identified can respond to Committee, if they
1	wish."
20	Do you see that?
21	A. I do.
22	Q. Does that refresh your recollection that when
23	Mr. Townsend first introduced the patent tracking list,
24	he described it as something that was voluntary?
25	A. Excuse me?
26	

1 JEDEC's work?

2	A. Well, as I said, AMI was the vision for AMI
3	was to coordinate the infrastructure development, and
4	that's still consistent with coordinate that work,
5	the infrastructure development around the standards
6	that came from JEDEC.
7	Q. Was it you said the standards that came from
	JEDEC. Was there any effort contemplated in this time
	period to have work going from AMI into JEDEC to be
10	proposed?
11	A. Well, I'm not sure that we defined a particular
12	direction either way. I don't recall a particular
13	discussion about either direction. Since I was
14	involved in both, from my perspective, I'm not sure
15	there was a particular direction in mind.
16	Q. Well, what had happened to the SLDRAM device
17	that was being developed by SLDRAM? Why was a decision
1	made to stop the development and become a different
1	kind of organization?
20	A. Well, it was my understanding I don't
21	have I can't tell you directly why it was stopped,
22	because I wasn't involved in the manufacture of it. I
23	can tell you only from things that I overheard at the
24	time. Would you like for me to give you that?
25	Q. Well, you were a member attending these
26	

meetings. You were a representative attending these 1 2 meetings. 3 A. That's correct, I was. 4 Q. And were you part of a decision that was made to stop the development at SLDRAM? Did you -- you 5 yourself participate in the discussion? 6 7 A. The discussion about stopping the work on SLDRAM? Q. Yes. 10 A. I may have been within some meetings where that 11 was discussed, yes. 12 Q. Was it your understanding that the memory manufacturers wanted to push DDR SDRAM instead of 13 14 trying to develop SLDRAM? The manufacturers that were members of SLDRAM. 15 A. No, sir, that was --16 17 MR. OLIVER: Objection, Your Honor, lack of foundation. 1 1 MR. PERRY: I'm just asking for his 20 understanding. JUDGE McGUIRE: Sustained. Restate the 21 22 question. MR. PERRY: All right. 23 BY MR. PERRY: 24 25 Q. What did you understand the reasons to be why 26

- 1 SLDRAM development stopped?

2	MR. OLIVER: Your Honor, he said that he could
3	repeat what others had said, but that was the extent of
4	his understanding.
5	JUDGE McGUIRE: Sustained.
6	BY MR. PERRY:
7	Q. Did you have an understanding about why SLDRAM,
	Inc. was going to stop trying to develop the SLDRAM
	device?
10	A. I didn't have a direct knowledge of why, no,
11	sir.
12	Q. Okay. But in any event, you had a proposal for
13	what SLDRAM, Inc. could become?
14	A. That's correct.
15	Q. And you thought it could become what you
16	outlined in this Exhibit 2729, correct?
17	A. Yes.
1	Q. And was it part of your vision that AMI could
1	do things JEDEC couldn't do?
20	A. I believe that I have used that terminology,
21	yes.
22	Q. And that included marketing?
23	A. It's it's perhaps the better way to state
24	it would be do things that JEDEC would have difficulty
25	doing, and yes, it would include marketing.
26	

1	Q. And in particular, marketing of the DDR device?
2	A. Sure. Marketing of JEDEC standard memory
3	devices, that was that's what the vision was. DDR
4	was one of those.
5	Q. Why was JEDEC standard memory devices chosen
6	for the marketing goal?
7	A. Well, JEDEC standard, they were I can't tell
	you exactly why they were chosen. I don't I don't
	know that I have an answer for you.
10	Q. Well, looking at the marketing coordination
11	discussion on page 3, which is page 4 of the exhibit,
12	it says, "Marketing Coordination has been the function
13	of the M14 group and that group should be folded into
14	the corporation, if for no other reason than to provide

1 never went to an M14 meeting?

2	A. I was in the room many times with many people
3	in this industry, and I was involved in the creation
4	and formulation of what became Advanced Memory
5	International and what was SLDRAM. I would expect that
6	the perhaps a lot of the members are all the same,
7	and so I can't say for sure I don't believe I ever
	attended necessarily a, per se, M14 meeting, because
	I'm not sure one ever took place, per se. I certainly
10	was in the room with individuals in the memory
11	industry, both private meetings and meetings with
12	groups of companies.
13	Q. And these were non-JEDEC meetings, correct?
14	A. They were I have certainly been involved in
15	JEDEC and non-JEDEC meetings with these companies, yes.
16	Q. You participated in numerous non-JEDEC meetings
17	that discussed standardization efforts that were going
1	on at JEDEC, correct?
1	A. I believe non I have participated in many
20	non-JEDEC meetings that have discussed JEDEC standard
21	activity, yes.
22	Q. And one of the goals of AMI was to develop
23	consensus on proposals that were being made for
24	standardization at JEDEC to speed the process, wasn't
25	it?
26	

1 A. I assume that's possible, yes. 2 Q. And wasn't it part of your vision for AMI2 that 3 you could assist companies that were manufacturing and 4 designing JEDEC-compliant DDR SDRAM in their efforts to compete with RDRAM? 5 6 A. No, sir, that wasn't the -- in the effort to 7 compete, no. In the effort to get the information out about DDR, yes. Q. Well, when you -- you went on road trips, 10 right, to customers? A. Yes, I did. 11 Q. And you were presenting information about DDR 12 SDRAM, correct? 13 14 A. Yes, I was. 15 Q. And they would ask you questions about RDRAM, wouldn't they? 16 17 A. Occasionally, that's correct. Q. And you would provide information about RDRAM, 1 1 correct? 20 A. I would only provide whatever I knew as far as information. 21 22 Q. And on some of these customer visits, you were accompanied by the manufacturer representatives for the 23 AMI board members, correct? 24 A. Yes, the -- some -- the visits often times 25 26

1	JEDEC-compliant DDR SDRAM that its average selling
2	price come down in the process in which production
3	volume goes up, the average selling price usually comes
4	down? It's called a production ramp, isn't it ?
5	

JUDGE McGUIRE: Go ahead.

2 BY MR. PERRY: 3 Q. Now, were you from time to time -- did you from 4 time to time send out a memo called Desi's Ramblings to AMI members? 5 A. Well, normally I did not send out memos to AMI 6 7 members. Normally this -- if I put together a presentation at all, it would be at a -- at an AMI meeting, and this looks like it came from one of those 10 meetings. 11 Q. Is this a memorandum that you prepared? More than likely, yes, it looks like it. 12 Α. Q. And at the time, June 21, 2001, had JEDEC 13 14 standardized DDR II? A. Had JEDEC standardized DDR II? 15 Q. That's a bad question. 16 17 Had the preliminary specifications for DDR II passed the stage of getting approval at the 42 1 1 committee stage? 20 A. These were about the same time frame, so it's possible. It may -- I'm not sure if this was before or 21 22 after. It was along about the same time period. Q. And on your road trips, were you also talking 23 about DDR II or were you focusing on existing 24 25 JEDEC-compliant products? 26

2	The next bullet point says, "Our message: DDR
3	systems are ready for production."
4	Do you see that?
5	A. I do.
6	Q. And then another bullet point, "Their
7	messages," and is that a reference to the messages you
	were bringing back from the motherboard manufacturers?
	A. That yes, it would be.
10	Q. And the first statement is, "DDR price is low
11	enough now make it stable."
12	A. Correct.
13	Q. What was the message you received and brought
14	back to the DRAM manufacturers from the motherboard
15	manufacturers about DDR price becoming stable?
16	A. The motherboard manufacturers at the time had
17	expressed that they wanted the price to be in the
1	same within DRAM is a commodity, and so because
1	of that, they wanted this to basically track commodity
20	prices, and the price changes daily, hourly, and the
21	message was that the motherboard makers were satisfied
22	that they could now they were satisfied with what
23	they were paying for memory at the time, including DDR,
24	which remember, it was fluctuating hour to hour, day
25	to day.

Q. If you look on page 5 of this memo, it says, "A 1 Few Findings." The third bullet point says, "After 2 market DDR volumes passed R ---- in April & the delta 3 4 was wider in May." Is that a reference to RDRAM? 5 Α. It is. 6 Why didn't you just write out RDRAM? 7 Ο. Α. I just didn't. Ο. What does it mean that the after market DDR 10 volumes passed RDRAM in April? A. The information that I had been provided 11 through market research firms said that it was -- the 12 after market was -- and these are people that buy 13 14 things off the shelf, Fry's or, you know, grocery 15 stores or wherever, that's the after market that would be a place where they would buy it, and that is market 16 17 data that I had been shown that said exactly what I said here. 1 Q. Well, one of the services that AMI was 1 providing was market data to its members, correct? 20 A. Not entirely. It was market data that I could 21 22 get, which there is some market data that isn't that openly available and other data that I could get, yes. 23 24 Q. Weren't you collecting market data from the AMI 25 members, putting it all together and publishing a 26

consensus production forecast for the members? 1 2 A. Production forecast? 3 Q. Yes. 4 Α. I had put together production time lines, yes. Q. Well, let me show you something that was marked 5 as RX-1935. 6 7 Pardon me. Do you recognize this to be an email from Lisa Rhoden? 10 A. I do. Q. To the AMI board members in December 2001? 11 12 A. I do. Q. And it says, "Dear AMI Board members: In our 13 14 Marketing/Technical meeting today, we discussed that I will gather projected volume information from all of 15 you on a quarterly basis." 16 17 Do you see that? A. I do. 1 1 Q. And then it says, "What I need to know --" 20 second paragraph, "What I need to know is your volume 21 projections for DDR2 and the timeframes involved." 22 Do you see that? I do. 23 Α. 24 Q. Why was AMI collecting volume projections for 25 DDR II from the major memory manufacturers in December 26

1 2001?

2 MR. OLIVER: Your Honor, I would simply like to 3 note for the record our ongoing objections to this line 4 of questioning.

5 JUDGE McGUIRE: All right, so noted, and let me 6 clarify earlier. I assume that this argument is 7 something that's going to be gone into in your case in chief essentially. Is that correct, Mr. Perry?

MR. PERRY: Yes. Well, Your Honor, we -- I'm not quite sure what your question means, but it's certainly something --

JUDGE McGUIRE: All right, let me -- I didn't quite hear you. Are we still talking about the allegation that there was a conspiracy here among the DRAM manufacturers?

MR. OLIVER: That seems to be where he's going with this, Your Honor, and to that extent, we wish to note our objection for the record.

JUDGE McGUIRE: Right, and I indicated in my previous order that I was -- I would entertain that to an extent, though I was not going to conduct a trial I think within a trial on that issue, so it is noted, your ongoing objection, and at this time, it's overruled. You don't have to state it every time he brings it up. It's an ongoing objection.

26

MR. OLIVER: Thank you, Your Honor.

JUDGE McGUIRE: And then at the time -- should you get into this at the presentation of your case in chief, then I'm going to make inquiry as to how you intend to outline that defense, and then I'm going to determine to what extent you're going to be authorized to go into that. So, are we clear there?

MR. PERRY: Yes, Your Honor, and just to make it clear, we believe there were two points made during the direct examination by Mr. Oliver from this witness that made it even more important for us to get into that. I'll be happy to make that argument to you now or save it, but what I'm trying to do is really prompted by the direct examination on two issues.

JUDGE McGUIRE: All right, I am going to let you go into it. It's just that the Court has taken note of the complaint counsel's continuing opposition to this line of questioning. So, you may proceed on that basis.

20 MR. OLIVER: Thank you, Your Honor.

21 MR. PERRY: And it may help if I say that I 22 don't have that much more for today, because as Your 23 Honor noted, we are going to build this case, to the 24 extent we're allowed to, in our case in chief, and we 25 have got a subpoena out to Mr. Rhoden, and I am just

trying to get some in today in this area just, God
 forbid, anything happened.

3 JUDGE McGUIRE: All right, continue. 4 MR. OLIVER: Your Honor, on that point, I would simply like to state again for the record that they 5 have had almost an entire day with Mr. Rhoden Friday, 6 7 half a day again today. We have specifically not objected to questions going beyond the scope of our direct. Because he was on their witness list, we did 10 want to allow them to conduct their direct at this time. 11 12 I don't think we need any ruling, because I'm not sure if it's going to arise or not, but I just want 13 14 to state for the record that we do not necessarily agree that they have a right to bring Mr. Rhoden back 15 again. 16 17 JUDGE McGUIRE: So noted. THE WITNESS: I would prefer not to come back 1 1 again. 20 JUDGE McGUIRE: I understand, Mr. Rhoden, I certainly understand. 21 22 While we're on this topic, how much more do you have at this time for cross for today, Mr. Perry? 23 24 MR. PERRY: Twenty minutes, Your Honor. 25 JUDGE McGUIRE: And then Mr. Oliver, how much

more after that for complaint counsel's own questioning 1 2 on redirect? 3 MR. OLIVER: I think we will be very brief, 4 Your Honor. JUDGE McGUIRE: Okay, then hopefully, sir, we 5 are going to get you out of here today, so --6 7 THE WITNESS: I hope so, Your Honor. Thank you. JUDGE McGUIRE: Mr. Perry, proceed. 10 MR. PERRY: Your Honor, I'd be happy to respond to Mr. Oliver's statement about bringing him back on 11 our case in chief. 12 JUDGE McGUIRE: All right, go ahead. 13 14 BY MR. PERRY: Q. All right, let me return to the question. Is 15 this a memorandum that Ms. Rhoden sent out to AMI board 16 17 members about collecting production information? A. It is. 1 1 Q. I'm not quite sure if there was a question 20 pending, but let me see if I can recapture when there 21 was an objection registered. 22 Why was it that AMI2 was collecting production volume projections or sales volume projections for DDR 23 II from the DRAM manufacturers? 24 25 A. The intent here was attempting to collect, 26

because as it turns out, we were never able to actually 1 2 get everyone involved to comply, so the -- the reason 3 that we were attempting to do it was so we could show 4 projections about the -- the volume projections in presentations to the industry, so they could see what 5 they could expect, but since I never got the data, I 6 7 was never able to put the -- put that particular aspect of it together on anything other than hearsay information. 10 Q. Well, you were aware, weren't you, when you 11 were at SLDRAM meetings that there was an effort ongoing to publish market forecasts based upon the DRAM 12 manufacturers' data, weren't you? 13 14 A. I don't have a direct recollection, but that's possible. 15 Q. Let me show you RX-1423, which shows you as 16 17 having received it. It's my only copy, I'm --JUDGE McGUIRE: Do you want to give him a copy 1 1 first so he can review it? 20 MR. PERRY: Yes, I'm sorry, that's my only one, but we'll put it up on the screen, give everybody a 21 22 chance to look at it. 23 May I? 24 BY MR. PERRY: 25 Q. Do you see -- let's talk about the email that's 26

1	on the	bottom half of the screen. Do you see that
2	you're	listed as a cc on this April 30, 1999 email?
3	Α.	Yes, I do.
4	Q.	It's from Terry Walther at Micron?
5	Α.	Yes, I do.
6	Q.	And it says, "At the last AMI meeting, Bernie
7	Marren	suggested we publish a market forecast for the
	differe	nt DRAM types."
		Who was Mr. Marren employed by?
10	A.	Excuse me?
11	Q.	Who was Mr. Marren employed by?
12	Α.	I believe Mr. Marren was employed by I can't

1	see, I'm trying to look to see if that's adopted as the
2	AMI forecast. And that's fine. I don't I don't
3	recall anything about an official forecast or
4	non-official forecast.
5	Q. Did AMI publish forecasts? Did you use
6	forecasts in your presentations?
7	A. I did use forecasts in relative forecasts in
	my presentations, yes, I did.
	Q. And were the forecasts based upon forecasts

A. I'm not sure that I would necessarily agree 1 2 with that, but they were certainly being presented -- I 3 don't know -- the part I'm having trouble with is the "promote." It's for information to be used by the 4 customer. 5 Q. Now, in -- when you were being examined by Mr. 6 7 Oliver, did you -- we can take that down -- did you intend to suggest that the price, the average selling price or any other price of JEDEC-compliant SDRAM or 10 DDR SDRAM had been impacted in any way by Rambus royalties on those devices? 11 12 A. The -- let me -- are you asking -- I'm trying to understand what you're asking me. 13 Q. Mr. Oliver asked you a question that led you to 14 refer to "mom and pop." 15 A. Yes. 16 17 Q. Were you intending to suggest in any way in your testimony that the price to any consumer, to any 1 1 non-manufacturer consumer of DRAM products, of 20 JEDEC-compliant DDR SDRAM or SDRAM devices, had been impacted by Rambus royalties on those devices? 21 22 A. I don't recall having that as part of my consideration. I'm not sure. I think the answer is I 23 don't know. 24 25 Q. Do -- that was -- let me ask that question. 26

1	Do you know whether or not the price to
2	purchasers of electronic devices, consumer purchasers
3	of electronic devices, whether the prices that those
4	folks have paid have been impacted in any way by Rambus
5	

MR. PERRY: Yes, I would like to move into
 evidence some of the exhibits that we referred to,
 asked the witness questions about. CX-375.

the functions that take place inside the device. 1 2 Q. You may have anticipated my next question, but 3 I do want the record to be clear. What does the dotted 4 line in this diagram represent? A. Okay, the dotted line is intended to represent 5 the external boundary of the device, such that 6 7 everything inside the dotted line is on the device, and everything outside the dotted line is outside the device, if you will. 10 Q. Now, if you could please expand the right-hand portion of that diagram. 11 12 If you look towards the right-hand part of the page, there is a small block with the letters DLL in 13 14 it. 15 Do you see that? A. Yes, I do. 16 17 Q. What does that represent? This would represent the DLL -- the DLL/PLL 1 Α. 1 that we actually have on the device for DDR memory. 20 Q. Is this the same PLL that we discussed on Friday? 21 22 A. Yes, it is. Q. Mr. Rhoden, I want to ask you about a second 23 topic, just to be certain that the record is clear. 24 Do you recall that earlier today Mr. Perry 25 26

showed you a letter dated July 4, 2001 from you to John 1 2 Kelly and Mr. McGhee with respect to certain patents 3 and allowed patents? 4 A. Yes, I do. Q. Now, what, if any, is your understanding of 5 whether patents relating to SyncLink or SLDRAM were 6 7 ever disclosed to JEDEC before July 4, 2001? A. Well, it was my understanding that all of them were disclosed inside of JEDEC in a verbal fashion and 10 that -- prior to that. 11 Q. What was the purpose of you writing a letter to Mr. Kelly and Mr. McGhee on July 4, 2001? 12 A. The purpose of writing the letter was to 13 14 confirm the previous verbal declarations that had been made in committee relative to all of the IP that was 15 held by AMI, and so it was merely a letter, a 16 17 formalized letter that we wanted to have on file at JEDEC. 1 1 Q. Now, I believe earlier today you testified --20 and please correct me if I misstate this -- but I believe you testified that or you described the 21 22 SyncLink architecture, if you will, and described it as having a -- I believe a packetized control and address 23 with separate data lines. Is that correct? 24 25 A. That is correct. 26

1296

Q. Do you have any understanding as to whether 1 2 that SyncLink architecture was ever standardized at 3 JEDEC? 4 A. It -- the SyncLink architecture at JEDEC was not standardized. The pinout I think is the only thing 5 that ever became standardized. 6 7 MR. OLIVER: No further questions, Your Honor. JUDGE McGUIRE: Thank you, Mr. Oliver. Mr. Perry, recross? 10 MR. PERRY: Just two or three on that last point. 11 MR. DETRE: And I have got a couple of 12 questions also, Your Honor. 13 14 MR. PERRY: You go first, Mr. Detre. JUDGE McGUIRE: All right, Mr. Detre, go ahead. 15 RECROSS EXAMINATION 16 BY MR. DETRE: 17 Q. Mr. Rhoden, Mr. Oliver just asked you about 1 JX-57, that was JESD79, which you described as the 1 extraction of the DDR standard from 21-C. Is that 20 21 right? 22 A. That was primarily the intent, to make it more user friendly, to flip things around and make it more 23 clean. 24 25 Q. And in particular, Mr. Oliver directed your 26

1 attention to page 8 of that document, the functional 2 block diagram. 3 A. Yes. 4 Q. And you pointed out a block in there that was marked DLL, correct? 5 6 A. That's correct. Q. Now, underneath that functional block diagram 7 is a note -- thank you. Have you seen Note 1 right underneath the functional block diagram? 10 A. Yes. 11 Q. And that note 1 states, "This Functional Block 12 Diagram is intended to facilitate user understanding of the operation of the device." 13 14 Do you see that? A. Yes. 15 16 Q. "It does not represent an actual circuit 17 implementation." 1 That's what it says, right? 1 A. It is a block diagram, yes. 20 Q. Which does not represent an actual circuit 21 implementation, right? 22 A. It does not. 23

1 21-C, correct?

A. The -- the two documents are -- are intended to
be tracked together.

Q. But I believe you also testified previously
that it is possible that when the extraction was done,
some mistakes were made in that extraction. Isn't that
right?

A. Certainly.

Q. In fact, what really controls is what ballots 10 were passed at the JEDEC meetings. That's what controls what should be in the standard, correct? 11 12 A. The -- the ballots that are passed through the committee are the ones that actually control the 13 14 details, if you will, inside the standard, yes. Q. And there was a ballot that passed which 15 applied to having a DLL enable/disable bit in the 16 17 extended mode register, correct? A. I believe that's correct, yes. 1 Q. Was there ever a ballot that passed about this 1 20 functional block diagram that we're talking about today in JESD79? 21 22 A. Yes, actually, there was a ballot that was for this entire document. 23 Q. And --24 25 A. So, it was passed in its entirety as a final 26

1 document. So, yes, there was.

2	Q. Was there anything in that ballot which said							
3	that an actual circuit implementation of a DDR SDRAM							
4	device, that DLL was required?							
5	A. I don't recall. It may be in the document.							
6	I'd have to review it, sir.							
7	Q. If you took that DLL that's in this functional							
	block diagram and you replaced it with some other							
	circuitry that was not a DLL but maintained the same							
10	timing margins for the device and you took that device							
11	and plugged it into a system, a computer system, would							
12	that work?							
13	A. If you replaced the DLL with a circuit that was							
14	functionally equivalent to a DLL							
15	MR. OLIVER: Your Honor, if I could object to							
16	the hypothetical question.							
17	JUDGE McGUIRE: Sustained.							
1	BY MR. DETRE:							
1	Q. Do you have you have an understanding, Mr.							
20	Rhoden, of what the DLL is used for in the DDR SDRAM							
21	device, correct?							
22	A. I believe so, yes.							
23	Q. And you also I believe, as you testified on							
24	Friday, believe that really the key parts of a standard							
25	are the parts that are required for interoperability of							
26								

1 devices, correct?

2	A. Well, the all parts of the standard are							
3	parts of the standard, and I'm not sure what words							
4	that that you're trying to to use here. Perhaps							
5	if you could ask me a question, I'll be glad to answer							
6	it, rather than agreeing to a rephrasing of I'm not							
7	sure what I exactly said, but							
	Q. Well, let me ask you the question.							
	A. Okay.							
10	Q. Is the main purpose of having a standard for							
11	DDR SDRAM in order to ensure interoperability?							
12	A. It certainly is one of the main purposes, yes.							
13	Q. And if you were able to replace that DLL with							
14	some other circuitry that was not a DLL but maintained							
15	the same timing margins, would you still have							
16	interoperability maintained?							
17	MR. OLIVER: Objection, Your Honor, calls for							
1	speculation.							
1	JUDGE McGUIRE: Any response, Mr. Detre?							
20	MR. DETRE: Well, Mr. Rhoden has testified							
21	about the purpose of the standard and what's required							
22	in order for something to be part of the standard and							
23	how important interoperability is for the standard.							
24	This really goes to whether the DLL is required for							
25	interoperability.							

1	MR. OLIVER: Your Honor, he has testified as a							
2	fact witness with respect to the development of the							
3	JEDEC standard and the operation of JEDEC-compliant							
4	parts, but he is not here as a witness to speculate.							
5	JUDGE McGUIRE: Sustained.							
6	BY MR. DETRE:							
7	Q. Okay, Mr. Rhoden, let me try it one other way.							
	Is do you know whether the DLL in the DDR							
	SDRAM standard is required for interoperability?							
10	A. I believe it probably is.							
11	Q. Okay. And what is that belief based on?							
12	A. The fact that it's written in the standard.							
13	Q. Do you know whether if you took that DLL and							
14	replaced it by some other circuitry that maintained the							

1	A. W	ell, I
2	Q. –	- discussions
3	A	- as I recall Mr. Peter Gillingham's
4	statement	, something along the line that any IP related
5		

JUDGE McGUIRE: Okay. I know a few days ago you had sent my office an email, and you had put forth the proposed testimony for two or three days ahead of time, and I found that to be quite helpful. So, if you could do that again starting I think next week, that would be helpful, and just be sure you send a copy to opposing counsel.

Anything else we need to take up before we adjourn today?

10 MR. OLIVER: Your Honor, I note that I did neglect to move into evidence two exhibits, if I could, 11 12 please. JUDGE McGUIRE: Okay, go ahead. 13 14 MR. OLIVER: CX-234, which is Release 9. MR. PERRY: No objection. 15 JUDGE McGUIRE: Entered. 16 17 (CX Exhibit Number 234 was admitted into evidence.) 1 MR. OLIVER: And JX-57, which is the JESP79 1 20 standard. MR. PERRY: No objection. 21 22 JUDGE McGUIRE: So entered. (JX Exhibit Number 57 was admitted into 23 24 evidence.) 25 JUDGE McGUIRE: All right, Counsel, thank you 26

1	very mu	ch. We'l]	convene	tomorrow n	morning at	9:30.
2	Hearing	adjourned	1.			
3		(Whereupo	on, at 3:	55 p.m., tl	he hearing	was
4	adjourn	ed.)				
5						
6						
7						
10						
11						
12						
13						
14						
15						
16 17						
1						
1						
20						
21						
22						
23						
24						
25						
26						

13081 600 64 560